## HP Engage One Pro G2 All-In-One system

## **FRONT VIEW**



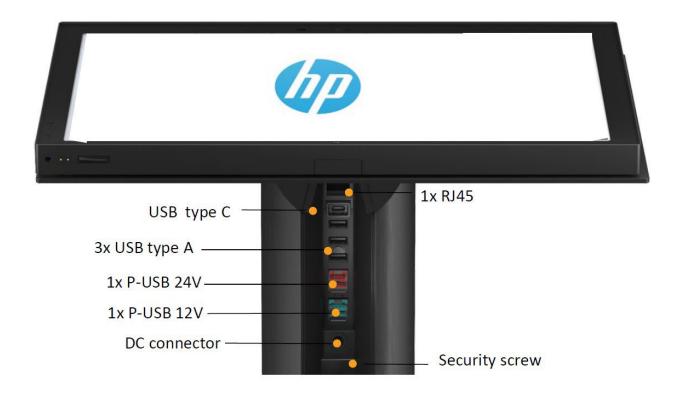


## **REAR VIEW**

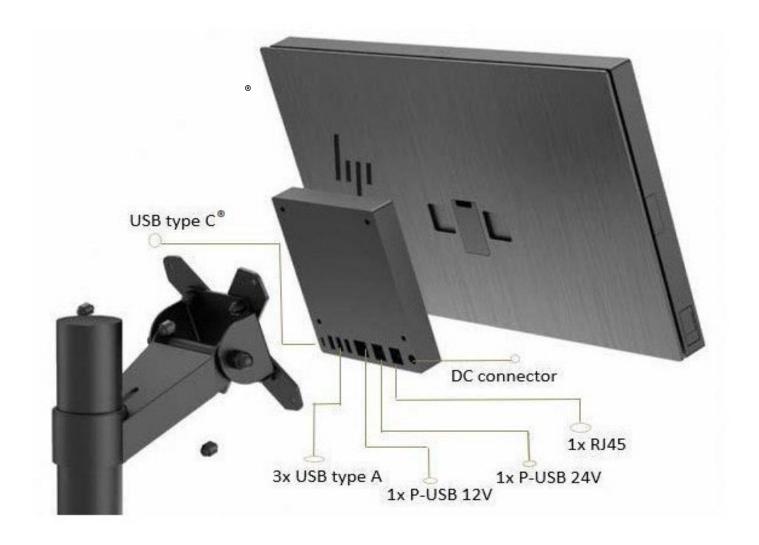




## HP Engage One Pro G2 Column hub



## HP Engage One Pro G2 VESA hub

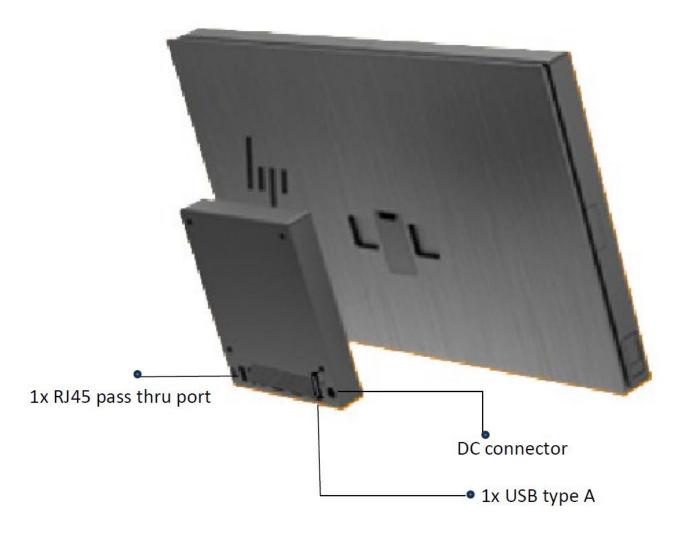


## HP Engage One Pro G2 Advanced Fan-less Hub





## ENGAGE ONE PRO USB-A (HUB-LESS) DONGLE



## Overview

## Component Breakdown

- Head unit screen sizes: 3 Choices 15.6", 19.5", 23.8"
   Landscape or portrait orientation
- Stand: 3 choices:
   Advanced stand,
   Pro stand,
   Slim VESA wall mount

- 3. Stability Base Plate or Counter mount & U-Shape Adapter
- 4. Hub: 4 Options based on I/ O requirements: Column hub, Advance hub, VESA mount hub, Hub-less

Not shown: Head unit connects with hub through a 140W Cable with secure screwed to connectivity base



### **Component Breakdown**

## HP Engage One Pro G2 Stand Features

1. Advanced Stand-Dual hinge with 12° vertical associate side flip to 140° on customer side



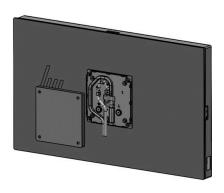
2. Engage One Pro stand-tilt 40° - 120°

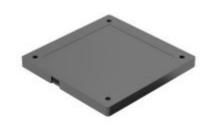


## **Component Breakdown**

## HP Engage One Pro G2 Stand Features

3. HP Engage One Pro G2 AiO Slim VESA mount (100x100mm)





4. HP Engage One Pro G2 AiO Advanced\* Stand Clean

5. HP Engage One Pro G2 AiO System Advanced\* stand with Counter Mount No stability plate- includes Counter Mounting

Stability Base Plate

Bracket\*\* (Requires 94mm hole)





#### Overview

### At A Glance

- Choice of 2 colors: Ebony Black & Ceramic White\*
   \*White only available in 15.6" and 23.8"
- Choice of 2 orientations: Landscape & portrait
- With or without Camera
- Choice of 3 Long lifecycle performance All-in-One (AiO) Retail System for retail and hospitality markets operator display:
  - 15.6" diagonal, FHD(1920 x 1080), touch, IPS, UWVA, anti-glare, 400 nits, 45% NTSC
  - o 19.5" diagonal, FHD(1920 x 1080), touch, VA, UWVA, anti-glare, 450 nits, 72% NTSC
  - 23.8" diagonal, FHD(1920 x 1080), touch, IPS, UWVA, anti-glare, 625 nits, 72% NTSC Note: Actual brightness will be lower with touch screen
- Choice of 2 column stand:
  - HP Engage One Pro G2 Advanced stand
  - HP Engage One Pro stand
- Choice of Mounting:
  - Clean counter- Place the connectivity hub under the counter
  - o All together- Place the hub directly under the stand
  - Slim VESA wall mount- Place the head unit on the wall
  - o Pole mount--Place the head unit on a single or back-to-back pole
- Intel® Q670E chipset, 35W Processors
- Processor choices:

Intel® Celeron® G Series

Intel® Celeron® G6900TE

#### Intel® Core™ 14th Generation

- o Intel® Core™ i3 14th generation processor
- o Intel® Core™ i5 14th generation processor
- o Intel® Core™ i7 14th generation processor
- Integrated: Intel® UHD Graphics 710 on Celeron; Intel® UHD Graphics 730 on i3 and i5, Intel® UHD Graphics 770 on i7
- Intel® Ethernet Connection I219-LM GbE, vPro® integrated network connection from head unit
- RTL8153CH Ethernet Connection from Advanced hub
- Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, vPro®;
- Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, non-vPro®
- Intel® WI-FI 6E AX211 WI-FI 6E and Bluetooth® 5.3 wireless card, non-vPro®
- Operating System choices:
  - Windows 11 Pro 64-bit / Windows 10 IoT Enterprise 2021 LTSC 64 / Windows 11 IoT Enterprise 2024 LTSC 64
  - FreeDOS 3.0
  - o SUSE Linux® Enterprise Server 15
  - o Google ChromeOS Flex
- Connectivity Base Choices
  - o HP Engage One Column hub:
  - o HP Engage One VESAhub
  - o HP Engage One Advanced Fan-less hub
  - o Hub-less
- Integrated peripheral options (can also be purchased and installed separately)
  - HP Engage One Pro MSR
  - o HP Engage One Pro G2 Bar Code Scanner (choose between 3 locations: left, right, bottom) of the head unit
  - o HP Engage One Pro Fingerprint Reader
  - HP Engage One Pro 6x6 Customer facing display with 2x20 line display emulation \*\*
    - \*\*The 2x20 line display emulation can be used on 6.6" CFD and future CFDs for Engage One Pro Virtual Line Display will work with any display. It defaults to 2x20, it can also be used for any other size line display such as 3x16 or 3x20, 5x10



### Overview

- Virtual Line Display will work with any display. It defaults to 2x20,, it can also be used for any other size line display such as 3x16 or 3x20, 5x10
- Industry-standard 100mm VESA mounting pattern allows for flexible use without the optional stand (Mounting hardware sold separately)
- (2) Two DDR5 Memory Slots (64 GB Maximum)
- Trusted Platform Module (TPM2.0)
- HP BIOSphere with HP Sure Start technology
- Cable Management Features-RJ45 extension
- ENERGYSTAR® certified configurations available, EU Compliant, RoHS2 Compliant, EPEAT® registered configurations available
- Standard Warranty Options:
  - a. 1/1/1 Standard Warranty
  - b. 90/90/90 available for North America
  - c. 3/3/3 Available for OEMs
  - d. Plus, Optional Extended Warranty
- 2 SODIMM Memory slots with up to 64 GBDDR5 SDRAM Transfer rates up to 5600 MT/s.
- 1x M.2 WLAN expansion slot
- 2xM.2 Storage slots
- 256 GBto up to 4 TB PCle® NVMe SSD First drive
- 256 GBto up to 4 TB PCle® NVMe SSD Second drive
- Integrated HD audio with Realtek ALC3247 codec with standards internal speakers and stereo headphone jack, 2W)
- HP Credential Guard; HP Device Guard; HP Support Assistant; HP BIOSphere with Sure Start Generation 6.0
- HP Sure Sense; HP Sure Click (Standard); HP Sure Admin; HP MIK(SCCM Integration); HP Image Assistant; HP BIOSphere with Sure Start Gen6; HP Client Security Manager Gen7; HP Sure Recover Gen3; HP Sure Run Gen3
- Intel® vPro® with AMT11.0;TPM2.0;HP System Software Manager; HP Image Assistant; HP Client Security Manager
- Display head Ports and Connectors: 1 audio-out; 2 USBType-A5Gbps signaling rate; 2 USB Type- A 5Gbps signaling rate (HP Sleep and Charge); 1 RJ-45 USBNIC; 1 140Wdata port Side: 1 Security lock slot
- Choice of 3 connectivity hubs:
  - HP Engage One Pro G2 Column hub:
    - 3x USB Type-A 5Gbps signaling rate
    - 1x RJ-45 NIC
    - 1x DCconnector
    - 3x USB 2.0 Type-A
    - 1x USB Type-C® 5Gbps signaling rate (27 WPower Delivery, Alt Mode DisplayPort™)
    - 1x 140Wdata port
    - 1x P-USB 12V
    - 1x P-USB 24V
  - HP Engage One Pro G2 VESA hub:
    - 3x USB Type-A 5Gbps signaling rate
    - 1x RJ-45 NIC
    - 1x DCconnector
    - 3x USB 2.0 Type-A
    - 1x USB Type-C® 5Gbps signaling rate (27 WPower Delivery, Alt Mode DisplayPort™)
    - 1x 140Wdata port
    - 1x P-USB 12V
    - 1x P-USB 24V
  - HP Engage One Pro G2 Advance fan-less hub
    - 1x cash drawer connector
    - 2x power serials



### Overview

- 4x USB Type-A 5Gbps signaling rate
- 1x RJ-45 NIC
- 1x DCconnector
- 1x USB Type-C® 5Gbps signaling rate (27 WPower Delivery, Alt Mode DisplayPort™)
- 1x140Wdata port]
- 2x P-USB 12V
- 1x P-USB 24V
- o Combination of Advance hub with Column hub; Combination of Advance hub with VESA hub.
- HP Engage One Pro G2 Hub-less
  - 1x USB type-A port and 1xRJ45 pass thru port

## NOTE: See important legal disclosures for all listed specs in their respective features sections. SECURITY DISCLAIMERS:

HP Essential Security requires Windows 10, includes various HP Sure security features and is available on HP Elite and Workstation products. See product details for included security features.

HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

HP Sure Recover Gen3 is available on select HP PCs and requires an open network connection. Not available on platforms with multiple internal storage drives. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. HP Sure Recover Gen3 requires an open network connection. You must back up important files, data, photos, videos, etc. before use to avoid loss of data.

HP Sure Start Gen6 is available on select HP PCs.

HP Sure Click is only supported on Intel Core i3, i5, and i7 processors.

HP Sure Click, Sure Run, Sure Recover & Sure Sense is supported on Win 10 Pro & Win 10 IoT Enterprise 2019 LTSC; but not on Win 10 IoT Enterprise 2016 LTSB.

For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.

HP BIOSphere Gen6 is available on select HP Pro and Elite PCs. See product specifications for details. Features may vary depending on the platform and configurations.



**Features** 

### OPERATING SYSTEM

**Preinstalled** Windows 11 Pro 64-bit <sup>1</sup>

Windows 10 IoT Enterprise 2021 LTSC Windows 11 IoT Enterprise 2024 LTSC

Google ChromeOS Flex

FreeDOS 3.0

Certified SUSE Linux®Enterprise Server 15<sup>2</sup>

#### NOTE:

 Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com">http://www.windows.com</a>

2. SUSE Enterprise Linux 15 SP6 YES Certification on a single platform configuration. More information about SUSE

YES certification on https://www.suse.com/partners/ihv/yes/

The following features are not supported by SUSE Linux Enterprise Desktop:

- Power Management features
- Multi-touch capabilities
- Systems configured with Linux do not qualify for ENERGY STAR®
- 3. Only available on certain configurations (please ask sales representative)

## Adapters and Cables

- HP USB-C® to DisplayPort
- HP USB-C® to HDMI
- HP USB-C<sup>®</sup> to VGA
- USB to Serial Port Adapter

## **NETWORKING/COMMUNICATIONS**

- Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, vPro®;\*, \*\*
- Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, non-vPro®;\*,\*\*
- Intel® WI-FI 6E AX211 WI-FI 6E and Bluetooth® 5.3 wireless card, non-vPro®;\*, \*\*
- Realtek RTL8153CH 10/100/1000MGbE Lan Chip:
  - o Supports Ethernet speeds: 10Mbps, 100Mbps, and 1Gbps
  - USB Interface: USB 3.0 for faster data transfer rates compared to USB 2.0
  - Auto-negotiation: Automatically negotiates the best speed (10Mbps, 100Mbps, or 1Gbps) with a connected device
  - Compact size: USB form factor makes it suitable for laptops and desktops with limited space
  - Power Management: Supports features like ACPI and Wake-on-LAN for efficient power consumption



#### **Features**

\*Wireless access point and Internet service required and not included. Availability of public wireless access points limited. The specifications for the 802.11ax WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the PC to communicate with 802.11ax WLAN devices. Wi-Fi 7 requires a wireless router.

sold separately, that supports 802.11be (Wi-Fi 7). Only available in countries where 802.11be is supported.

\*\* Wi-Fi 7 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

\*\*\*Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 7 (802.11be) is backwards compatible with prior 802.11ax (Wifi6)specs.

### NEAR FIELD COMMUNICATION

NXP NPC300 Near Field Communication Module

## **PORTS**

#### HP Engage One Pro G2 Head unit I/O:

- 1x 140W data port (PDO cable to Head Unit)<sup>1</sup>
- 1x RJ45 vPro NIC
- 1x 3.5mm Audio Jack support CTIA type
- 4x Integrated USB-A Gen1 Peripherals ports
- 2x USB3.2 G1 Type-A / 900mA
- 2x USB3.2 G1 Type-A / 2.2A

Internal access door for the SSD and USB-Port Type A on Motherboard Dimensions for USB-Port Type A: 55mm L includes plug / 16mm W / 8mm

#### HP Engage One Pro G2 Column hub I/O

- 3x USB3.2 G2 Type-A / 900mA
- 1x RJ45 (cable direct from Head unit)
- 1x DC connector
- 1x P-USB 12V
- 1x P-USB 24V
- 1x USB3.2 G1 Type-C® DP Alt Mode / 27W
- 1x 140W data port (PDO cable to Head Unit)<sup>1</sup>

## HP Engage One Pro G2 VESA hub I/O

- 3x USB3.1 G1 Type-A / 900mA
- 1x RJ45 (cable direct from Head unit)
- 1x DC connector
- 1x P-USB 12V
- 1x P-USB 24V
- 1x USB3.2 G1 Type-C® DP Alt Mode / 27W
- 1x 140W data port (PDO cable to Head Unit)<sup>1</sup>

### HP Engage One Pro G2 Advanced Fan-less hub I/O

- 1x RJ12 Cash Drawer
- 2x 12V P-USB
- 1x 24V P-USB
- 2x DB9 P-Serial
- 4x USB3.2 G1 Type A/900mA
- 1x RJ45 USB NIC



### **Features**

- 1x DC connector
- 1x USB 3.1 G2 Type-C® DP Alt Mode / 27W
- 1x 140W data port (PDO cable to Head Unit) 1

## HP Engage One Pro G2 Hubless I/O

- 1x USB Type A
- 1x DC connector
- 1x RJ45 NIC

**NOTE 1:** HP 140W port only compatible with the 140W cable included with the product. Cable required for the HP Engage One Pro G2 to operate

## **USB SPECIFICATION**

SpeedTerminologyHi-Speed USB 480Mbps signaling rateUSB 2.0USB 5Gbps signaling rateUSB 3.2 Gen 1

## SOFTWARE COMPONENTS AND APPLICATIONS

#### **BIOS**

- HP BIOSphere Gen6
  - o Protect and manage the foundation of your POS System
  - Building on over a decade of BIOS security leadership, HP BIOSphere Gen6 offers an ecosystem of protections to help defend your system, including automated protections, customizable safeguards, and easy manageability
- HP Secure Erase<sup>1</sup>
- Device Guard Enablement

#### Additional features of the HP BIOS Features

o Power-On password

#### Software

- HP Privacy Settings
- HP Setup Integrated OOBE
- HP Easy Clean<sup>2</sup>
- HP Notifications
- myHP

### **Manageability Features**

- HP Driver Packs
- HP Manageability Integration Kit<sup>3</sup>
- HP Image Assistant
- HP Smart Support<sup>4</sup>

#### Notes:

- 1. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane™.
- 2. HP Easy Clean requires Windows and will disable the keyboard, display and touchpad only. Ports are not disabled.



## QuickSpecs

#### **Features**

- 3. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.
- 4. HP Smart Support is available to commercial customers through your HP Service Representative and HP Factory Configuration Services; or it can be downloaded at: http://www.hp.com/smart-support. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights.

## **Security Management**

- HP BIOSphere Gen 6<sup>1</sup>
- HP Client Security Manager Gen7<sup>6</sup>
- HP Multi-Factor Authenticate -
- HP SpareKey -
- HP Sure Start<sup>6</sup>
- HP Sure Run<sup>4</sup> -
- HP Sure Recover<sup>4</sup>-Recover quickly and minimize downtime
  - Driven by the HP Endpoint Security Controller, HP Sure Recover enables users to reimage their systems quickly and securely using only a network connection - no IT intervention needed.

### Other Security Features

- HP Engage One AiO System Biometric Fingerprint Reader (optional)
- Bolt to counter mechanism
- VESA mounting
- Keyed Cable Lock
- Trusted Platform Module TPM 2.0
- Drive lock
- USB enable/disable (via BIOS)
- Power-on password (via BIOS)
- Setup password (via BIOS)
- Tamper Resistant Screw affixed on stand of the system unit, used to secure display head to stand without Quick Released
- HP vPRO Support

#### Notes:

- HP BIOSphere Gen6 features may vary depending on the platform and configuration.
- 2. HP Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation
- 3. agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/computrace- agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data
- 4. HP Sure Click, Sure Run, Sure Recover & Sure Sense is supported on Win 10 Pro & Win 10 IoT Enterprise 2019 LTSC; but not on Win 10 IoT Enterprise 2016 LTSB.
- 5. HP Client Security Manager Gen7 requires Windows
- 6. HP Sure Start Gen6 is available on select HP PCs.

## **PROCESSORS**



### **Features**

- Intel® Celeron® G6900TE with Intel® UHD710 Graphics (2.4 GHz P-core base frequency, 4 MB L3 cache, 2 P-cores, 2 threads)
- Intel® Core™ i3-14100T with Intel® UHDGraphics 730 (2.7 GHz P-core base frequency, up to 4.4 GHz P-core Max Turbo frequency, 12 MB L3 cache, 4 P-cores and 0 E-cores, 8 threads)
- Intel® Core™ i5-14500T with Intel® UHD770 Graphics (1.2 GHz E-core base frequency, 1.7 GHz P-core base frequency, up to 3.4 GHz E-core Max Turbo frequency, up to 4.8 GHz P-core Max Turbo frequency, 24 MB L3 cache, 6 P-cores and 8 E-cores, 20 threads), supports Intel® vPro® Technology
- Intel® Core™ i7-14700T with Intel® UHDGraphics 770 (0.9 GHz E-core base frequency, 1.3 GHz P-core base frequency, up to 3.7 GHz E-core Max Turbo frequency, up to 5.0 GHz P-core Max Turbo frequency, 33 MB L3 cache, 8 P-cores and 12 E-cores, 28 threads), supports Intel® vPro® Technology

### PROCESSORS FAMILY

14th Gen 35W Intel® Core™ processors

### **NOTES:**

- 1. Multi-core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a mea configuration surement of higher performance.
- 2. Intel® Turbo Boost technology requires a PC with a processor with Intel Turbo Boost capability. Intel Turbo Boost performance varies

depending on hardware, software and overall system. See http://www.intel.com/technology/turboboost for more information.

3. For full Intel® vPro® functionality, Windows 10 Pro 64 bit, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or WLAN card and TPM 2.0 are required. Some functionality requires additional 3rd party software in order to run. See http://intel.com/vpro



## **Technical Specifications**

## INTEL® 14th GENERATION CORE™ vPRO® PROCESSORS

Intel® Core™ i5-14500T with Intel® UHD770 Graphics (1.2 GHz E-core base frequency, 1.7 GHz P-core base frequency, up to 3.4 GHz E-core Max Turbo frequency, up to 4.8 GHz P-core Max Turbo frequency, 24 MB L3 cache, 6 P-cores and 8 E-cores, 20 threads), supports Intel® vPro® Technology

Intel® Core™ i7-14700T with Intel® UHDGraphics 770 (0.9 GHz E-core base frequency, 1.3 GHz P-core base frequency, up to 3.7 GHz E-core Max Turbo frequency, up to 5.0 GHz P-core Max Turbo frequency, 33 MB L3 cache, 8 P-cores and 12 E-cores, 28 threads), supports Intel® vPro® Technology

The HP Engage One Pro G2 AiO System Retail System features this technology and includes processors that are part of the Intel® Stable Image. Platform Program (SIPP) designed to ensure the stability promise inherent in the value proposition of the HP Engage One Pro G2 AiO System Retail System.

## Intel® Advanced Management Technology (AMT) v11.6

An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state.

- AMT 11.6 includes the following advanced management function
- Power Management (on, off, reset
- Hardware Inventory (includes BIOS and firmware revisions
- Hardware Alerting
- Agent Presence
- · System Defense Filters
- SOL/USBR
- Cisco NAC/SDN Support
- ME Wake-on-LAN DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the PC connects to the IT or service provider console for maintenance. Remote PCs can get required patches, be inventoried, etc. by connecting to their IT console or Service Provider when it's convenient
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- · Host-based set-up and configuration
- Management Engine (ME) firmware roll back
- Wireless AMT functionality on Desktop (WoDT)
- Enhanced KVM resolution

\*Some functionality of this technology, such as Intel Active management technology and Intel Virt ualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro® technology is dependent on 3rd party software providers. Compatibility with future "virtual appliances" is yet to be determined.

\*\* Intel® Active Management Technology requires an Intel®AMT-enabled chipset, network hardware and software, as well as connection with a power source and a corporate network connection. Setup requires configuration by the purchaser and may require scripting with the management console or further integration into existing security frameworks to enable certain functionality. It may also require modifications of implementation of new business processes.



# QuickSpecs

**Technical Specifications** 



## Technical Specifications

## OPERATOR DISPLAY\*

15.6" Diagonal Wide Aspect, Projective Capacitive, Anti-glare, Anti-smudge, IPS Display with Projective Capacitive

**Touch** 

Touch Technology Projected Capacitive Touchscreen

Resolution 1920 x 1080

Aspect Ratio 16:9 Max Color 16.2M

Brightness Typical 400 Nits\*

Contrast Ratio Typical 800:1

**Pixel Pitch** 0.17925 x 0.17925mm

Viewing Angle Horizontal 178°, Vertical 178° Response rate 25ms (Typical On / Off)

Backlight LED

Operating Temperature range 0 to 50°C (+50°C as panel surface temperature)

19.5" Diagonal Wide Aspect, Projective Capacitive, Anti-glare, Anti-smudge, UWVA, VA Display, with discrete

**Projective Capacitive Touch** 

Touch Technology Projected Capacitive Touchscreen

**Resolution** 1920 x 1080

Aspect Ratio 16:9
Max Color 16.7M

BrightnessTypical 450 Nits\*Contrast RatioTypical 3000:1Pixel Pitch0.2265 x 0.2210mm

Viewing AngleHorizontal 170°, Vertical 170°Response rate25ms (Typical On / Off)

Backlight LED

**Operating Temperature range** 0 to 50°C (+50°C as panel surface temperature)

23.8" Diagonal Wide Aspect, Projective Capacitive, Anti-glare, Anti-smudge, IPS Display with discrete Projective

**Capacitive Touch** 

**Touch Technology** Projected Capacitive Touchscreen

Resolution 1920 x 1080

Aspect Ratio 16:9
Max Color 16.7M

Brightness Typical 625 Nits\*

Contrast Ratio 1000:1

**Pixel Pitch** 274.5 um x 2274.5 um

Viewing Angle Horizontal 178°, Vertical 178° Response rate 14ms (Typical On / Off)

Backlight LED

**Operating Temperature range** 0 to 50°C (+ 50°C as panel surface temperature)

\*NOTE: Nits is the measure of the typical brightness of the panel as specified, prior to anti-glare coating



## **Technical Specifications**

### \*NOTES:

Portrait Display. With a Portrait Head Unit, the pre-OS environment will be displayed 90° in Landscape. Once the Windows OS loads, then the display will show Portrait.

\*All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.



## **Technical Specifications-Graphics**

## Intel® HD Graphics (integrated)

## **Integrated Graphics**

Intel® UHD Graphics 770 (integrated on 14<sup>th</sup> gen Core i7/ i5) Intel® UHD Graphics 730 (integrated on 14<sup>th</sup> gen Core i3) Intel® UHD Graphics 710 (integrated on G Series Celeron® G6900TE)

## **DisplayPort**

DisplayPort over the optional USB-C® module

## Memory

The actual amount of maximum graphics memory can be >6GB. System memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and system memory use.

## Maximum Graphic Memory

Windows 10 > 6 GB

## Maximum Color Depth

64bits/pixel

10<sup>th</sup> Generation Intel® Core™ processors:

- Next Generation Intel® Clear Video Technology HDSupport is a collection of video playback and enhancement features that improve the end user's viewing experience
  - o Encode/ transcode HDcontent
  - o Playback of high-definition content including Blu-ray Disc
  - o Superior image quality with sharper, more colorful images

## **Graphics/Video API Support**

- DirectX Video Acceleration (DXVA) support for accelerating video processing o Full AVC/VC1/MPEG2/HEVC HW Decode
- Advanced Scheduler 2.0, 1.0
- Windows 11, Linux OS Support
- DirectX 12.1
- OpenGL 4.4
- Open CL 1.2 (Intel® HD Graphics 730)
- Open CL 1.2/2.0 (Intel® HD Graphics 710)

**NOTE:** the actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.

#### Supported Display Resolutions and Refresh Rates

Note: Other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rate
640x480	60Hz 640 x 480 67Hz
640x480	72Hz
640x480	75Hz
720x400	70Hz



## **Technical Specifications-Graphics**

800x600	60Hz
800x600	75Hz
1024x768	60Hz
1024x768	75Hz
1280x960	60Hz
1280x720	60Hz
1280x1024	60Hz
1280x1024	75Hz
1440x900	60Hz
1440x900	75Hz
1680x1050	60Hz
1920x1080	60Hz
3440x1440	60Hz 3440 x 1440 30Hz
2048x1536	60Hz
4096x2160	60Hz
4096x2160	60Hz



## Technical Specifications-Memory

## **MEMORY**

Type

DDR5-5600 SODIMM (transfer rates up to 5600 MT/s)

Maximum

64 GB

# of Slots

2 SODIMM

#### **Memory Upgrades**

- RAM8GB (1x8GB) DDR5 5600
- RAM8GB (1x8GB) DDR5 5600 PRC
- RAM16GB (1x16GB) DDR5 5600
- RAM16GB (2x8GB) DDR5 5600
- RAM16GB (1x16GB) DDR5 5600 PRC
- RAM16GB (2x8GB) DDR5 5600 PRC
- RAM32GB (1x32GB) DDR5 5600
- RAM32GB (2x16GB) DDR5 5600
- RAM32GB (1x32GB) DDR5 5600 PRC
- RAM32GB (2x16GB) DDR5 5600 PRC
- RAM64GB (2x32GB) DDR5 5600

**NOTE:** Memory speed 5600 MT/s can be achieved via two SODIMMs per channel (2DPC) when populated with the same part number.

For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system. Memory modules support data transfer rates up to 2400 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate. CAUTION: You must shut down the Retail System and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the Retail System is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause

irreparable damage to the memory modules or system board.



## Technical Specifications-Storage

## SOLID STATE STORAGE

Drive Bays: (2) M.2 PCle x4 2280/2230 Combo (for storage)

#### PCIe NMVe Solid State Drives (SSD)1

- SSD 256GB 2280 PCle NVMe Value
- 256GB PCle 2280 NVMe Self Encrypted OPAL2 Value Solid State Drive
- SSD 512GB 2280 PCle NVMe Value
- SSD 512GB 2280 PCle-4x4 NVMe Three Layer Cell
- SSD 1TB 2280 PCle NVMe Value
- SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell
- SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell
- 4TB PCIe-4x4 2280 NVMe Three Layer Cell double-sided M.2 Solid State Drive

## Storage accelerator

NVMe RAID 1

#### Notes:

1. Storage DriveLock does not work with Self-Encrypting or Optane based storage

**NOTE:** For hard drives and solid state drives, GB=1 billion bytes. TB=1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

#### SSD 256G2280 PCle NVMe Value

Capacity256GBInterfacePCIe NVMe

Maximum Sequential Read2000 MB/s ±20%Maximum Sequential Write900 MB/s ±20%Logical Blocks500,118,192

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

**Features** Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

### 256GB PCle 2280 NVMe Self Encrypted OPAL2 Value Solid State Drive

Capacity 256GB

Interface PCle NVMe

Form Factor M.2
Height 2.38mm



## Technical Specifications-Storage

Width 22mm
Length 80mm
Weight <10g

Maximum Sequential Read2000 MB/s ±20%Maximum Sequential Write900 MB/s ±20%Logical Blocks500,118,192

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

Features TCG Opal 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

#### 512 GB M.2 2280 PCIe NVMe Three Layer Cell Value SSD

#### SSD 512 GB 2280 PCle NVMe Value

Capacity 512GB

Interface PCIe NVMe

Form Factor M.2
Height 2.38mm
Width 22mm
Length 80mm
Weight <10g

Maximum Sequential Read2200 MB/s ±20%Maximum Sequential Write1000 MB/s ±20%Logical Blocks1,000,215,215

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

#### SSD 512GB 2280 PCIe-4x4 NVMe Three Layer Cell

Capacity 512GB

Interface PCIe NVMe

Form Factor M.2
Height 2.38mm
Width 22mm
Length 80mm
Weight <10g

Maximum Sequential Read6400 MB/s ±20%Maximum Sequential Write3500 MB/s ±20%



## QuickSpecs

## Technical Specifications-Storage

**Logical Blocks** 1,000,215,215

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

### SSD 1TB 2280 PCle NVMe Value

Capacity 1TB

Interface PCIe NVMe

Form Factor M.2
Height 2.38mm
Width 22mm
Length 80mm
Weight <10g

Maximum Sequential Read2200 MB/s ±20%Maximum Sequential Write1600 MB/s ±20%Logical Blocks2,000,409,264

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

### SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell

Capacity 1TB

Interface PCle NVMe

Form Factor M.2
Height 2.38mm
Width 22mm
Length 80mm
Weight <10g

Maximum Sequential Read $6400 \, \text{MB/s} \pm 20\%$ Maximum Sequential Write $5000 \, \text{MB/s} \pm 20\%$ Logical Blocks2,000,409,264

Operating Temperature 0° to 70°C (32° to 158°F) [ambient temp]

Features APST; ASPM L1.2; NVME spec 1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.



## QuickSpecs

## Technical Specifications-Storage

### SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell

Capacity 2TB

Interface PCle NVMe

Form Factor M.2
Height 2.38mm
Width 22mm
Length 80mm
Weight <10g

Maximum Sequential Read $6400 \, \text{MB/s} \pm 20\%$ Maximum Sequential Write $5000 \, \text{MB/s} \pm 20\%$ Logical Blocks4,000,797,360

**Operating Temperature** 0° to 70°C (32° to 158°F) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

## 4TB PCIe-4x4 2280 NVMe Three Layer Cell double-sided M.2 Solid State Drive

Capacity 4TB

Interface PCIe NVMe

Form Factor M.2
Height 2.38mm
Width 22mm
Length 80mm
Weight <10g

Maximum Sequential Read $6400 \, \text{MB/s} \pm 20\%$ Maximum Sequential Write $5000 \, \text{MB/s} \pm 20\%$ Logical Blocks8,001,594,720

Operating Temperature 0° to 70°C(32° to 158°F) [ambient temp]

Features Pyrite 2.0; TRIM; L1.2

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.

#### 4TB 2280 PCIe-3x4 NVMe TLC Solid State Drive



## QuickSpecs

## **Technical Specifications-Storage**

Unformat ted Capacit y 4TB

Interface PCle Gen 3

Form Factor M.2
Height 2.38mm
Width 22mm
Lengt h 80mm
Weight <10g

Maximum Sequential ReadUp to 6600MB/sMaximum Sequent ial WriteUp to 5200MB/sLogical Blocks2,000,409,264

**Operating Temperature** 0° to 70°C(32° to 158°F) [ambient temp]

**NOTE:** For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 10) of system disk is reserved for the system recovery software.



## Technical Specifications - Networking and Communications

## **Networking/Communications**

### Ethernet (RJ-45)

- Intel® I219-LMGigabit Network Connection LOM (standard)
- Realtek RTL8153CH

#### Wireless

- Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, vPro®;\*
- Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, non-vPro® \*\*
- Intel® WI-FI 6E AX211 WI-FI 6E and Bluetooth® 5.3 wireless card, non-vPro®\*\*\*

#### Notes:

#### **NIC Fundamentals:**

By default, the HP BIOS set the HUB WOLsetting to disabled state, which will not allow wake signal from the USB bus to initiate a wake event. On Engage One Plus, the Embedded Lan Controller is enabled by default and is what HP recommend using as the primary nic for WOLcapability as seen in the BIOS F10 menu If customer has a reason to use the HUB NICand wants to wake the system from that NIC. They must enable wake events for the HUB to get the functionality.

\*Wireless access point and Internet service required and not included. Availability of public wireless access points limited.

The specifications for the 802.11ax WLAN are draft specifications and are not final. If the final specifications differ from

the draft specifications, it may affect the ability of the PCto communicate with 802.11ax WLAN devices. Wi-Fi 6 requires a wireless router, sold separately, that supports 802.11ax (Wi-Fi 6). Only available in countries where 802.11ax is supported.

\*\* Wi-Fi 6 is backwards compatible with prior 802.11 specs.

You require a wireless access point and internet service. Limited public wireless access points are available. The specifications for the 802.11 WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it might affect the ability of the notebook to communicate with other 802.11 WLAN devices.

Intel® i219LM 10/100/1000	Intel® i219LM 10/100/1000 Integrated NIC		
Connector	RJ-45		
System Interface	PCI (Intel® proprietary) + SMBus		
Data rates supported	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s		
IEEE Compliance	IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable) IEEE 802.3az EEE (Energy Efficient Ethernet)		



Performance	TCP/IP/UDP Checksum Offload (configurable)
	Protocol Offload (ARP & NS)
	Large send offload and Giant send offload
	Receiving Side Scaling(Hash Mode Only)
	Jumbo Frame 9K
Power consumption	Cable Disconnetion: 25mW 100Mbps Full Run: 450mW 1000bp Full Run: 1000mW WoL
•	Enable(S3/S4/S5): 50mW WoL Disable(S3/S4/S5): 25mW
Power Management	ACPI compliant - multiple power modes
	Situation-sensitive features reduce power consumption
	Advanced link down power saving for reducing link down power consumption
Management Interface	Auto MDI/MDIV Orogovycz ogblo dotoction
Management Interface	Auto MDI/MDIX Crossover cable detection
IT Manageability	Wake-on-LAN from modem standby or sleep state (Magic Packet and Microsoft Wake-Up
,	Frame);
	Wake-on-LAN from off (Magic Packet only)
	PXE 2.1 Remote Boot
	Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30))
	Comprehensive diagnostic and configuration software suite
	Virtual Cable Doctor for Ethernet cable status
Security & Manageability	Intel® vPro® support with appropriate Intel® chipset components
Intel Wi-Fi 6 AX201 + BT5 (80	2.11ax 2x2, vPro, supporting gigabit file transfer speeds)non-vPro
Wireless LAN Standards	
	IEEE 802.11b
	IEEE 802.11g
	IEEE 802.11n
	IEEE 802.11ac
	IEEE 802.11ax
	IEEE 802.11d
	IEEE 802.11e
	IEEE 802.11h
	IEEE 802.11i
	IEEE 802.11k
	IEEE 802.11r
	IEEE 802.11v
Interoperability	Features Wi-Fi 6 technology
Intel Wi-Fi 6 AX201 + BT5 (80 Wireless LAN Standards	12.11ax 2x2, vPro, supporting gigabit file transfer speeds)non-vPro   EEE 802.11a



Frequency Band	802.11b/g/n/ax
rrequericy baria	• 2.402 - 2.482 GHz
	802.11 <sup>a</sup> /n/ac/ax
	• 4.9 - 4.95 GHz (Japan)
	• 5.15 - 5.25 GHz
	• 5.25 - 5.35 GHz
	• 5.47 - 5.725 GHz
	• 5.825 - 5.850 GHz
Deter Deter	
Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
	• 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz)
	• 802.11ax : MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz)
Modulation	Direct Sequence Spread Spectrum
	OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
Security <sup>3</sup>	<ul> <li>IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> </ul>
	AES-CCMP: 128 bit in hardware
	802.1x authentication
	<ul> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> </ul>
	WPA2 certification
	• IEEE 802.11i
	WAPI
Network Architecture Models	Ad-hoc (Peer to Peer)
	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power <sup>2</sup>	• 802.11b:+18.5dBm minimum
	• 802.11g:+17.5dBm minimum
	• 802.11 <sup>a</sup> :+18.5dBm minimum
	802.11n HT20(2.4GHz):+15.5dBm minimum
	• 802.11n HT40(2.4GHz):+14.5dBm minimum
	802.11n HT20(5GHz):+15.5dBm minimum
	802.11n HT40(5GHz):+14.5dBm minimum
	802.11ac VHT80(5GHz): +11.5dBm minimum
	<ul> <li>802.11ac VHT160(5GHz): +11.5dBm minimum</li> </ul>
Power Consumption	Transmit mode: 2.0 W
, and a second part of the secon	Receive mode: 1.6 W
	Idle mode (PSP) 180 mW (WLAN Associated)
	Idle mode: 50 mW (WLAN unassociated)
	Connected Standby: 10mW
	Radio disabled: 8 mW
Power Management	ACPI and PCI Express compliant power management
	802.11 compliant power saving mode
Receiver Sensitivity <sup>3</sup>	-802.11b, 1Mbps: -93.5dBm 32 maximum
Received Sensitivity	-802.11b, 11Mbps : -84dBm 32 maximum
	802.11a/g, 6Mbps:-86dBm maximum
	802.11a/g, 54Mbps:-72dBm maximum     802.11a MCS07: 67dPm maximum
	802.11n, MCS07: -67dBm maximum     800.11n, MCS0F: -64dBm maximum
	802.11n, MCS15:-64dBm maximum     800.11ma MCS0:-84dBm maximum
	<ul> <li>802.11ac, MCS0: -84dBm maximum</li> <li>802.11ac, MCS9: -59dBm maximum</li> </ul>



	-202 11av MCC11/L	HT40): -59dBm maximum	
	-	VHT160): -58.5dBm maximum	
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure		
antonia typo	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support		
		munications and Bluetooth® communications	
Form Factor		MiniCard with CNVi Interface	
Dimensions	1. Type 2230 : 2.3 x		
	2. Type 1216: 1.67 x		
Weight	1. Type 2230 : 2.8g 2. Type 126: 1.3g	1. Type 2230 : 2.8g 2. Type 126: 1.3g	
Operating Voltage	3.3v +/- 9%		
Temperature	Operating	14° to 158° F (-10° to 70° C)	
	Non-operating	-40° to 176° F (-40° to 80° C)	
Humidity	Operating	10% to 90% (non-condensing)	
·	Non-operating	5% to 95% (non-condensing)	
Altitude	Operating	0 to 10,000 ft (3,048 m)	
	Non-operating	0 to 50,000 ft (15,240 m)	
LED Activity	LED Amber - Rad	io OFF; LED White - Radio ON	
HP Integrated Module with Blueto	ooth <sup>®</sup> 4.0/4.1/4.2/5.0/5	5.1 Wireless Technology	
Bluetooth® Specification	4.0/4.1/4.2/5.0/5.1 Compliant		
Frequency Band	2402 to 2480 MHz	2402 to 2480 MHz	
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)		
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps  BLE: 1 Mbps data rate; throughput up to 0.2 Mbps  Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels.		
	•	onous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-symmetric (3-EV5)	
Transmit Power	The Bluetooth® component shall operate as a Class II Bluetooth®device with a maximum transmit power of +9.5 dBm for BR and EDR.		
Power Consumption	Peak (Tx) 330 mW	Peak (Rx) 230 mW	
·	Selective Suspend 17 mW		
Bluetooth® Software Supported Link Topology	Microsoft Windows Bluetooth® Software		
Power Management	Microsoft Windows ACPI, and USB Bus Support		
Certifications	FCC (47 CFR) Part	t 15C, Section 15.247 & 15.249	
Bluetooth® Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping LE Dual Mode LE Link Layer LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging &Interlaced Scan BT4.2 ESR08 Compliance LE Secure Connection- Basic/ Full LE Privacy 1.2 -Link Layer Privacy LE Privacy 1.2 -Extended Scanner Filter Policies LE Data Packet Length Extension FAXProfile (FAX)		



	Basic Imaging Profile (BIP)2 Headset Profile (HSP)
	Hands Free Profile (HFP)
	Advanced Audio Distribution Profile (A2DP)
Bluetooth® Profiles Supported	BT4.1-ESR 5/6/7 Compliance LE Link Layer Ping
	LE Dual Mode
	LE Link Layer
	LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels Train Nudging & Interlaced Scan
	BT4.2 ESR08 Compliance
	·
	LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy
	LE Privacy 1.2 - Extended Scanner Filter Policies
	LE Data Packet Length Extension FAX Profile (FAX)
	Basic Imaging Profile (BIP)2 Headset Profile (HSP)
	Hands Free Profile (HFP)
	Advanced Audio Distribution Profile (A2DP)
Realtek RTL8822CE 802.11ac 2	x2 Wi-Fi + BT5
Wireless LAN Standards	IEEE 802.11a
	l

Wireless LAN Standards	IFFF 000 11 ~
Wil Clock B at Ctarlaal ac	IEEE 802.11a
	IEEE 802.11b
	IEEE 802.11g
	IEEE 802.11n
	IEEE 802.11ac
	IEEE 802.11d
	IEEE 802.11e
	IEEE 802.11h
	IEEE 802.11i
	IEEE 802.11k
	IEEE 802.11r
	IEEE 802.11v
Interoperability	Wi-Fi®certified
Frequency Band	802.11b/g/n
	• 2.402 - 2.482 GHz
	802.11 <sup>a</sup> /n/ac
	• 4.9 - 4.95 GHz (Japan)
	• 5.15 – 5.25 GHz
	• 5.25 - 5.35 GHz
	• 5.47 - 5.725 GHz
	• 5.825 – 5.850 GHz
Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
	• 802.11ac : MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, & 80MHz)
Modulation	Direct Sequence Spread Spectrum
	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security3	<ul> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/ b/ g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> </ul>



WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.     WPA2 certification     IEEE 802.11i     WAPI  Network Architecture Models  Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)  Roaming  IEEE 802.11 compliant roaming between access points		
WPA2 certification		OOL:1X ddd Ioridoddori
FEE 802.111		
WAP    Ad-hoc (Peer to Peer)   Infrastructure (Access Point Required)   Moming		
Ad-hoc (Peer to Peer)   Infrastructure (Access Point Required)		• IEEE 802.11i
Infrastructure (Access Point Required)		• WAPI
EEE 802.11	Network Architecture Models	
B02.11p: +175.68bm minimum		Infrastructure (Access Point Required)
802.11g : 117.5dBm minimum     802.11n HT20(2.4GHz) : 145.5dBm minimum     802.11n HT20(2.4GHz) : 145.5dBm minimum     802.11n HT20(3.4GHz) : 145.5dBm minimum     802.11n HT40(3.6Hz) : 145.5dBm minimum     802.11n HT40(3.6Hz) : 145.5dBm minimum     802.11n HT40(5.6Hz) : 145.5dBm minimum     802.11n Ht50.6Hz] : 15.5dBm minimum     180.11n Ht40(5.6Hz) : 145.5dBm mini	Roaming	IEEE 802.11 compliant roaming between access points
802.11n HT20(2.4GHz): +15.5dBm minimum     802.11n HT20(2.4GHz): +15.5dBm minimum     802.11n HT20(3.4GHz): +15.5dBm minimum     802.11n HT20(5.6Hz): +15.5dBm minimum     802.11n HT20(5.6Hz): +15.5dBm minimum     802.11n HT40(5.6Hz): +14.5dBm minimum     802.11n Ht40(5.6Hz): +14.	Output Power2	802.11b:+18.5dBm minimum
802.11n HT20(2.4GHz): +15.5dBm minimum		• 802.11g: +17.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum		• 802.11 <sup>a</sup> : +18.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum     802.11n HT40(5GHz): +145.dBm minimum     802.11ac VHT80(5GHz): +11.5dBm 35 maximum     802.11ac VHT160(5GHz): +11.5dBm minimum     802.11ac VHT160(5GHz): +11.5dBm minimum     802.11ac VHT160(5GHz): +11.5dBm minimum     1EEE 802.11a     1EEE 802.11b     1EEE 802.11b     1EEE 802.11a     1EEE 802.11a     1EEE 802.11a     1EEE 802.11a     1EEE 802.11a     1EEE 802.11b     1EEE 802.11r		• 802.11n HT20(2.4GHz): +15.5dBm minimum
B02.11n HT40(5GHz): +14.5dBm minimum		• 802.11n HT40(2.4GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm 35 maximum     802.11ac VHT80(5GHz): +11.5dBm minimum     10.10 Mirel Wi-Fi 6 AX201 + BT5 (802.11ax 2x2, non-vPro, supporting gigabit file transfer speeds) non-vPro		• 802.11n HT20(5GHz): +15.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm 35 maximum   802.11ac VHT80(5GHz): +11.5dBm minimum   Intel Wi-Fi 6 AX201+ BT5 (802.11ax 2x2, non-vPro, supporting gigabit file transfer speeds) non-vPro   Wireless LAN Standards    EEE802.11b    EEE802.11c    EEE802.11c    EEE802.11c    EEE802.11d    EEE802.11d    EEE802.11d    EEE802.11t    EEE802.11t		• 802.11n HT40(5GHz): +14.5dBm minimum
- 802.11ac VHT160(5GHz): +11.5dBm minimum		
IEEE802.11a   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11c   IEEE802.11c   IEEE802.11c   IEEE802.11c   IEEE802.11d   IEEE802.11d   IEEE802.11d   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11r   IEEE802.11r   IEEE802.11r   IEEE802.11c		
IEEE802.11a   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11c   IEEE802.11c   IEEE802.11c   IEEE802.11c   IEEE802.11d   IEEE802.11d   IEEE802.11d   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11b   IEEE802.11r   IEEE802.11r   IEEE802.11r   IEEE802.11c	Intel Wi-Fi 6 AX201 + BT5 (802 1	lax 2x2 non-vPro supporting giggbit file transfer speeds) non-vPro
IEEE 802.11b   IEEE 802.11g   IEEE 802.11n   IEEE 802.11n   IEEE 802.11n   IEEE 802.11d   IEEE 802.11d   IEEE 802.11d   IEEE 802.11d   IEEE 802.11l   IEEE	-	
IEEE 802.11g   IEEE 802.11n   IEEE 802.11n   IEEE 802.11d   IEEE 802.11d   IEEE 802.11d   IEEE 802.11d   IEEE 802.11h   IEEE 802.11h   IEEE 802.11h   IEEE 802.11h   IEEE 802.11h   IEEE 802.11r   IEEE 802.11r   IEEE 802.11r   IEEE 802.11r   IEEE 802.11r   IEEE 802.11r   IEEE 802.11v   IEEE	Wil eless LAI Votalidal ds	
IEEE 802.11n		
IEEE 802.11ac   IEEE 802.11d   IEEE 802.11d   IEEE 802.11d   IEEE 802.11d   IEEE 802.11h   IEEE 802.11h   IEEE 802.11h   IEEE 802.11k   IEEE 802.11k   IEEE 802.11r   IEEE 802.11r   IEEE 802.11r   IEEE 802.11r   IEEE 802.11r   IEEE 802.11r   IEEE 802.11d   IEE		
IEEE802.11a   IEEE802.11d   IEEE802.11b   IEEE802.11h   IEEE802.11h   IEEE802.11l   IEEE802.11l   IEEE802.11l   IEEE802.11t   IEEE802.11t   IEEE802.11v   IEE802.11v   IEE8802.11v   I		
IEEE 802.11d   IEEE 802.11e   IEEE 802.11h   IEEE 802.11h   IEEE 802.11k   IEEE 802.11k   IEEE 802.11r   IEEE		
IEEE 802.11e   IEEE 802.11h   IEEE 802.11h   IEEE 802.11t   IEEE 802.11r   IEEE		
IEEE 802.11h   IEEE 802.11k   IEEE 802.11k   IEEE 802.11v   IEEE 802.11b   IEEE		
IEEE802.11i		
IEEE802.11k   IEEE802.11r   IEEE802.11v     Interoperability   Features Wi-Fi6 technology     S02.11b/g/n/ax     2.402 - 2.482 GHz     802.11g/n/ac/ax     4.9 - 4.95 GHz (Japan)     5.15 - 5.25 GHz     5.25 - 5.35 GHz     5.25 - 5.35 GHz     5.47 - 5.725 GHz     5.825 - 5.850 GHz     S02.11b:1, 2, 5.5, 11 Mbps     802.11b:1, 2, 5.5, 11 Mbps     802.11g:6, 9, 12, 18, 24, 36, 48, 54 Mbps     802.11g:6, 9, 12, 18, 24, 36, 48, 54 Mbps     802.11a:6, 9, 12, 18, 24, 36, 48, 54 Mbps     802.11a:MCS0 ~MCS15, (20MHz, and 40MHz)     802.11a:MCS0 ~MCS15, (20MHz, and 40MHz, 40MHz, 80MHz & 160MHz)     802.11a:MCS0 ~MCS11, (1SSand 2SS) (20MHz, 40MHz, 80MHz & 160MHz)     Modulation   Direct Sequence Spread Spectrum     OFDMBPSKOPSKCCK, 16-OAM, 64-OAM, 256-OAM, 1024OAM     IEEEcompliant 64 / 128 bit WEPencryption for a/b/g mode only     AES-CCMP:128 bit in hardware		
IEEE 802.11r   IEEE 802.11v     IEEE 802.11v   Features Wi-Fi6 technology     Frequency Band   802.11b/g/n/ax     • 2.402 - 2.482 GHz     802.119/n/ac/ax     • 4.9 - 4.95 GHz (Japan)     • 5.15 - 5.25 GHz     • 5.25 - 5.35 GHz     • 5.47 - 5.725 GHz     5.825 - 5.850 GHz     5.825 - 5.850 GHz     5.825 - 5.850 GHz     5.825 - 5.850 GHz     802.11b; 1, 2, 5.5, 11 Mbps     802.11a; 6, 9, 12, 18, 24, 36, 48, 54 Mbps     802.11a; 6, 9, 12, 18, 24, 36, 48, 54 Mbps     802.11a; MCS0 ~MCS15, (20MHz, and 40MHz)     802.11a; MCS0 ~MCS9, (1SS, and 2SS)(20MHz, 40MHz, 80MHz &160MHz)     802.11a; MCS0 ~MCS9, (1SS, and 2SS)(20MHz, 40MHz, 80MHz &160MHz)     802.11a; MCS0 ~MCS1, (1SS, and 2SS)(20MHz, 40MHz, 80MHz &160MHz)     802.11a; MCS0 ~MCS1, (1SS, and 2SS)(20MHz, 40MHz, 80MHz &160MHz)     Modulation   Direct Sequence Spread Spectrum     OFDMBPSKOPSKCCK, 16-OAM, 64-OAM, 256-OAM, 1024OAM     IEEEcompliant 64 / 128 bit WEPencryption for a/b/g mode only     AES-CCMP:128 bit in hardware		
IEEE 802.11v		
Security3   Features Wi-Fi6 technology		
802.11b/g/ n/ ax	Interoperability	
• 2.402 - 2.482 GHz 802.119/n/ ac/ ax  • 4.9-4.95 GHz (Japan) • 5.15-5.25 GHz • 5.25-5.35 GHz • 5.47 - 5.725 GHz 5.825 - 5.850 GHz  • 802.11b:1, 2, 5.5, 11 Mbps • 802.11g:6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a:6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a:6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a:6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a:6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a:6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a:MCSO ~MCS15, (20MHz, and 40MHz) • 802.11ac:MCSO ~MCS15, (20MHz, 40MHz, 40MHz, 80MHz & 160MHz) 802.11ax:MCSO ~MCS11, (1SSand 2SS) (20MHz, 40MHz, 80MHz & 160MHz)  Modulation  Direct Sequence Spread Spectrum OFDMBPSK, OPSK, COK, 16-OAM, 64-OAM, 256-OAM, 1024OAM  • IEEEcompliant 64 / 128 bit WEPencryption for a / b / g mode only • AES-CCMP:128 bit in hardware	·	<u> </u>
802.11a'/n/ac/ax	riequency band	
• 4.9-4.95 GHz (Japan) • 5.15-5.25 GHz • 5.25-5.35 GHz • 5.47-5.725 GHz 5.825-5.850 GHz  • 802.11b:1,2,5.5,11 Mbps • 802.11g:6,9,12,18,24,36,48,54 Mbps • 802.11a:6,9,12,18,24,36,48,54 Mbps • 802.11n:MCS0 ~MCS15,(20MHz,and 40MHz) • 802.11ac:MCS0 ~MCS15,(20MHz,and 40MHz,40MHz,80MHz&160MHz) • 802.11ac:MCS0 ~MCS9,(1SS,and 2SS)(20MHz,40MHz,80MHz&160MHz) 802.11ac:MCS0 ~MCS11,(1SSand 2SS)(20MHz,40MHz,80MHz&160MHz)  Modulation  Direct Sequence Spread Spectrum OFDMBPSK,QPSK,CCK,16-QAM,64-QAM,256-QAM,1024QAM  • IEEEcompliant 64 / 128 bit WEPencryption for a/b/g mode only • AES-CCMP:128 bit in hardware		
• 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz 5.825 – 5.850 GHz  • 802.11b:1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: MCS0 ~MCS15, (20MHz, and 40MHz) • 802.11ac: MCS0 ~MCS9, (1SS, and 2SS)(20MHz, 40MHz, 80MHz &160MHz) • 802.11ax: MCS0 ~MCS11, (1SS and 2SS)(20MHz, 40MHz, 80MHz &160MHz) 802.11ax: MCS0 ~MCS11, (1SS and 2SS)(20MHz, 40MHz, 80MHz &160MHz)  Modulation  Direct Sequence Spread Spectrum  OFDMBPSK, OPSK, CCK, 16-OAM, 64-OAM, 256-OAM, 1024OAM • IEEE compliant 64 / 128 bit WEPencryption for a / b / g mode only • AES-CCMP:128 bit in hardware		
• 5.25 - 5.35 GHz • 5.47 - 5.725 GHz 5.825 - 5.850 GHz  • 802.11b:1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: MCS0 ~MCS15, (20MHz, and 40MHz) • 802.11ac: MCS0 ~MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz &160MHz) 802.11ac: MCS0 ~MCS11, (1SSand 2SS) (20MHz, 40MHz, 80MHz &160MHz)  Modulation  Direct Sequence Spread Spectrum  OFDM,BPSK,OPSK,CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM  • IEEEcompliant 64 / 128 bit WEPencryption for a / b / g mode only • AES-CCMP.128 bit in hardware		
• 5.47 - 5.725 GHz 5.825 - 5.850 GHz  • 802.11b:1,2,5.5,11 Mbps • 802.11g:6,9,12,18,24,36,48,54 Mbps • 802.11a:6,9,12,18,24,36,48,54 Mbps • 802.11n:MCS0 ~MCS15,(20MHz,and 40MHz) • 802.11ac:MCS0 ~MCS9,(1SS,and 2SS)(20MHz,40MHz,80MHz &160MHz) 802.11ax:MCS0 ~MCS11,(1SSand 2SS)(20MHz,40MHz,80MHz &160MHz)  Modulation  Direct Sequence Spread Spectrum OFDM,BPSK,QPSK,CCK,16-QAM,64-QAM,256-QAM,1024QAM  • IEEEcompliant 64/128 bit WEPencryption for a/b/g mode only • AES-CCMP:128 bit in hardware		
5.825 - 5.850 GHz     • 802.11b:1, 2, 5.5, 11 Mbps     • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps     • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps     • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps     • 802.11a: MCS0 ~ MCS15, (20MHz, and 40MHz)     • 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz & 160MHz)     802.11ax: MCS0 ~ MCS11, (1SSand 2SS) (20MHz, 40MHz, 80MHz & 160MHz)     Modulation		
Data Rates         • 802.11b:1, 2, 5.5, 11 Mbps           • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps         • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps           • 802.11n: MCS0 ~MCS15, (20MHz, and 40MHz)         • 802.11ac: MCS0 ~MCS9, (1SS, and 2SS)(20MHz, 40MHz, 80MHz &160MHz)           • 802.11ax: MCS0 ~MCS11, (1SSand 2SS)(20MHz, 40MHz, 80MHz &160MHz)         • Direct Sequence Spread Spectrum           OFDM,BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM         • IEEEcompliant 64 / 128 bit WEPencryption for a/b/g mode only           • AES-CCMP:128 bit in hardware		
<ul> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11n: MCS0 ~MCS15, (20MHz, and 40MHz)</li> <li>802.11ac: MCS0 ~MCS9, (1SS, and 2SS)(20MHz, 40MHz, 80MHz &amp;160MHz)</li> <li>802.11ax: MCS0 ~MCS11, (1SSand 2SS)(20MHz, 40MHz, 80MHz &amp;160MHz)</li> <li>Modulation</li> <li>Direct Sequence Spread Spectrum</li> <li>OFDMBPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM</li> <li>IEEEcompliant 64 / 128 bit WEPencryption for a/b/g mode only</li> <li>AES-CCMP:128 bit in hardware</li> </ul>	Data Datas	
• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11n: MCS0 ~ MCS15, (20MHz, and 40MHz) • 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS)(20MHz, 40MHz, 80MHz & 160MHz) 802.11ax: MCS0 ~ MCS11, (1SSand 2SS)(20MHz, 40MHz, 80MHz & 160MHz)  Modulation  Direct Sequence Spread Spectrum OFDMBPSK, OPSK, CCK, 16-OAM, 64-OAM, 1024OAM  • IEEE compliant 64 / 128 bit WEPencryption for a / b / g mode only • AES-CCMP: 128 bit in hardware	Data Kales	·
• 802.11n:MCS0 ~MCS15,(20MHz, and 40MHz)     • 802.11ac:MCS0 ~MCS9,(1SS, and 2SS)(20MHz, 40MHz, 80MHz &160MHz)     802.11ax:MCS0 ~MCS11,(1SSand 2SS)(20MHz, 40MHz, 80MHz &160MHz)  Modulation  Direct Sequence Spread Spectrum     OFDMBPSK,OPSK,CCK, 16-QAM, 64-QAM, 1024QAM  • IEEEcompliant 64 / 128 bit WEPencryption for a/b/g mode only     • AES-CCMP:128 bit in hardware		· ·
• 802.11ac:MCS0 ~MCS9,(1SS,and 2SS)(20MHz,40MHz,80MHz &160MHz)     802.11ax:MCS0 ~MCS11,(1SSand 2SS)(20MHz,40MHz,80MHz &160MHz)  Modulation  Direct Sequence Spread Spectrum  OFDMBPSK,QPSK,CCK,16-QAM,64-QAM,256-QAM,1024QAM  • IEEEcompliant 64 / 128 bit WEPencryption for a/b/g mode only  • AES-CCMP:128 bit in hardware		· · · · · · · · · · · · · · · · · · ·
802.11ax:MCS0 ~MCS11,(1SSand 2SS)(20MHz,40MHz,80MHz &160MHz)  Modulation  Direct Sequence Spread Spectrum  OFDMBPSK,QPSK,CCK,16-QAM,64-QAM,1024QAM  • IEEEcompliant 64 / 128 bit WEPencryption for a/b/g mode only  • AES-CCMP:128 bit in hardware		
Direct Sequence Spread Spectrum OFDMBPSK,OPSK,CCK,16-QAM,64-QAM,256-QAM,1024QAM  • IEEEcompliant 64 / 128 bit WEPencryption for a/b/g mode only • AES-CCMP:128 bit in hardware		
OFDMBPSK,QPSK,CCK,16-QAM,64-QAM,256-QAM,1024QAM  • IEEEcompliant 64 / 128 bit WEPencryption for a / b / g mode only  • AES-CCMP:128 bit in hardware	No di lation	
• IEEEcompliant 64 / 128 bit WEPencryption for a / b / g mode only • AES-CCMP:128 bit in hardware	Modulation	· · · ·
AES-CCMP:128 bit in hardware		
	Security3	•
802.1x authentication		
		802.1x authentication



	WPA,WPA2: 802.1x. WPA-PSK,WPA2-PSK,TKIP,and AES.	
	WPA2certification	
	• IEEE802.11i	
	• WAPI	
Network Architecture Models	Ad-hoc (Peer to Peer)	
	Infrastructure (Access Point Required)	
Roaming	IEEE802.11 compliant roaming between access points	
Output Power2	• 802.11b:+18.5dBm minimum	
	• 802.11g:+17.5dBm minimum	
	• 802.11 <sup>a</sup> :+18.5dBm minimum	
	• 802.11n HT20(2.4GHz):+15.5dBm minimum	
	• 802.11n HT40(2.4GHz):+14.5dBm minimum	
	• 802.11n HT20(5GHz):+15.5dBm minimum	
	• 802.11n HT40(5GHz):+14.5dBm minimum	
	• 802.11ac VHT80(5GHz): +11.5dBm minimum	
	802.11ac VHT160(5GHz): +11.5dBm minimum	
	802.11axHT40(2.4GHz):+10dBm minimum	
Davis On Company House	802.11axVHT160(5GHz):+10dBm minimum	
Power Consumption	Transmit mode 2.0 W	
	Receive mode 1.6 W	
	Idle mode (PSP)180 mW(WLANAssociated)	
	Idle mode 50 mW(WLANunassociated)	
	Connected Standby 10mW     Padia diagbled 8 mW	
Dawanklanananant	Radio disabled 8 mW  ACRIGARD DOUGLASS A CONTRIBUTE TO A	
Power Management	ACPland PCIExpress compliant power management 802.11 compliant power saving mode	
	802.11 compliant power saving mode	
Receiver Sensitivity	•802.11b, 1Mbps:-93.5dBm 33 maximum	
,	•802.11b, 11Mbps:-84dBm 33 maximum	
	802.11a/g, 6Mbps:-86dBm maximum	
	802.11a/g, 54Mbps:-72dBm maximum	
	802.11n,MCS07:-67dBm maximum	
	• 802.11n,MCS15:-64dBm maximum	
	• 802.11ac, MCS0:-84dBm maximum	
	802.11qc,MCS9:-59dBm maximum	
	•802.11ax, MCS11(HT40):-59dBm maximum	
	• 802.11ax, MCS11(VHT160):-58.5dBm maximum	
Ant enna type	High efficiency antenna with spatial diversity, mounted in the display enclosure	
	Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN	
	MIMOcommunications and Bluetooth® communications	
Form Factor	PCI-Express M2MiniCard with CNVi Interface	
Dimensions	1. Type 2230:2.3 x22.0 x30.0 mm	
	2. Type 1216:1.67 x12.0 x16.0 mm	
Weight	1. Type 2230:2.8g	
	2. Type 126:1.3g	
	, , , , , , , , , , , , , , , , , , ,	



### Technical Specifications - Networking and Communications

Operating Voltage	3.3v+/-9%			
Temperature	Operating Non-operating	14° to 158° F(-10° to 70° C) -40° to 176° F(-40° to 80° C)		
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)		
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)		
LEDActivity	LEDAmber - Rad	lio OFF;LEDOff - Radio ON		
HP Integrated Module with Bluetooth	° 4.0/ 4.1/ 4.2/ 5.0/ 5	5.1 Wireless Technology		
Bluetooth® Specification	4.0/4.1/4.2/5.0/5.	1 Compliant		
Frequency Band	2402 to 2480 MH	łz		
Number of Available Channels	Legacy:0~79(1 M	Hz/CH)BLE:0~39(2 MHz/CH)		
Data Rates and Throughput	Legacy: 3 Mbps	data rate; throughput up to 2.17 Mbps		
	BLE:1Mbps date	a rate; throughput up to 0.2 Mbps		
	Legacy: Synchronous Connect ion Oriented links up to 3, 64 kbps, voice channels.			
Transmit Power	The Bluetooth® component shall operate as a Class II Bluetooth® device with a maximum transmit power of +9.5 dBm for BRand EDR.			
Power Consumption	Peak (Tx) 330 mWPeak (Rx) 230 mW Selective Suspend 17 mW			
Bluetooth® Software Supported Link Topology	Microsoft Window	ws Bluetooth® Software		
Power Management	Microsoft Window	s ACPI, and USBBus Support		
Certifications	FCC(47 CFR)Part 15C, Section 15.247 &15.249 ETS 300 328, ETS 300 826 Low Voltage Directive IEC60950 UL, CSA, and CEMark			
Bluetooth® Profiles Supported	BT4.1-ESR5/6/7 Compliance LELink Layer Ping LEDual Mode LELink Layer LELow Duty Cycle Directed Advertising LEL2CAPConnection Oriented Channels Train Nudging &Interlaced Scan BT4.2 ESR08 Compliance LESecure Connection- Basic/Full LEPrivacy 1.2 -Link Layer Privacy LEPrivacy1.2 -Extended Scanner Filter Policies LEData Packet Length Extension FAXProfile (FAX) Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP) Advanced Audio Distribution Profile (A2DP)			
Realtek RTL8822CE802.11ac 2x2 \	Wi-Fi + BT5			



### Technical Specifications - Networking and Communications

Mirologo I AN Otam dan da	FFF 000 11 ~	
Wireless LAN Standards	IEEE802.11a	
	IEEE802.11b	
	EEE802.11g  EEE802.11n	
	IEEE802.111ac	
	IEEE802.11d	
	IEEE802.11e	
	IEEE802.11h	
	IEEE802.11i	
	IEEE802.11k	
	IEEE802.11r	
	IEEE802.11v	
Interoperability	Wi-Fi®certified	
Frequency Band	802.11b/g/ n	
l roquonoy Buna	• 2.402 - 2.482 GHz	
	802.11 <sup>a</sup> /n/ ac	
	• 4.9 - 4.95 GHz (Japan) • 5.15 - 5.25 GHz	
	• 5.25 – 5.35 GHz	
	• 5.25 - 5.35 GHz	
	5.825 - 5.850 GHz	
Data Rates	• 802.11b:1,2,5.5,11 Mbps	
Data Nates	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps	
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps	
	·	
	• 802.11n:MCS0 ~MCS15,(20MHz, and 40MHz) 802.11ac:MCS0~MCS9,(1SS,and 2SS)(20MHz,40MHz&80MHz)	
Modulation		
	Direct Sequence Spread Spectrum BPSK,QPSK,CCK, 16-QAM, 64-QAM, 256-QAM	
Security3	IEEE and WiFicompliant 64/128 bit WEPencryption for a/b/g mode only	
	AES-CCMP:128 bit in hardware	
	802.1x authentication	
	WPA,WPA2: 802.1x.WPA-PSK,WPA2-PSK,TKIP,and AES.	
	WPA2certification	
	• IEEE802.11i	
	• WAPI	
Network Architecture Models	Ad-hoc (Peer to Peer)	
Network Architecture Models	Infrastructure (Access Point Required)	
Roaming	IEEE802.11 compliant roaming between access points	
Output Power2	802.11b :+18.5dBm minimum	
Output Power2		
	• 802.11g:+17.5dBm minimum	
	• 802.11 <sup>a</sup> :+18.5dBm minimum	
	• 802.11n HT20(2.4GHz):+15.5dBm minimum	
	• 802.11n HT40(2.4GHz):+14.5dBm minimum	
	• 802.11n HT20(5GHz):+15.5dBm minimum	
	• 802.11n HT40(5GHz):+14.5dBm minimum	
	802.11ac VHT80(5GHz): +11.5dBm 35 maximum	
	802.11ac VHT160(5GHz): +11.5dBm minimum	
Power Consumption	Transmit mode: 2.0 W	
	Receive mode :1.6 W	
	<ul><li>Idle mode (PSP)180 mW(WLANAssociated)</li><li>Idle mode :50 mW(WLANunassociated)</li></ul>	



### Technical Specifications - Networking and Communications

	Connecte     Radio disabled: 8	ed Standby/Modern Standby: 10mW 3 mW	
Power Management	ACPland PCIExpress compliant power management 802.11 compliant power saving mode		
Receiver Sensitivity	802.11b, 1Mbps: -93.5dBm 35 maximum 802.11b, 11Mbps: -84dBm 35 maximum 802.11a/ g, 6Mbps:-86dBm 35 maximum 802.11a/g, 54Mbps:-72dBm 35 maximum 802.11n, MCS07:- 67dBm 35 maximum 802.11n, MCS15:-64dBm 35 maximum 802.11ac, MCS0:-84dBm 35 maximum • 802.11ac, MCS9:-59dBm maximum		
Antenna type	Two embedded du	High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth® communications	
Form Factor	PCI-Express M.2Mir	niCard with CNVi Interface	
Dimensions		3. Type 2230 : 2.3 x22.0 x 30.0 mm 4. Type 1216:1.67 x12.0 x16.0 mm	
Weight	3. Type 2230 :2.8g 4. Type 126:1.3g		
Operating Voltage	3.3v+/-9%		
Temperature	Operating 14° to 158° F(-10° to 70° C) Non-operating -40° to 176° F(-40° to 80° C)		
Humidit y	Operating Non-operating	, , , , , , , , , , , , , , , , , , , ,	
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
LEDActivity	LEDAmber – Radio OFF;LEDOff – Radio ON		
HP Integrated Module with Bluetooth	<b>°</b> 4.0/ 4.1/ 4.2/ 5.0 W	/ireless Technology	
Bluetooth® Specification	4.0/4.1/4.2/5.0 Co	mpliant	
Frequency Band	2402 to 2480 MHz		
Number of Available Channels	Legacy:0~79(1 MHz/CH)BLE:0~39(2 MHz/CH)		
Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps		
	BLE : 1 Mbps data rate; throughput up to 0.2 Mbps		
	Legacy: Synchronous Connect ion Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/ 177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)		
Transmit Power	The Bluetooth® component shall operate as a Class II Bluetooth® device with a maximum transmit power of +4 dBm for BRand EDR.		
Power Consumption	Peak (Tx) 330 mWF	Peak (Tx) 330 mWPeak (Rx) 230 mW Selective Suspend 17 mW	
Bluetooth® Software Supported Link Topology	Microsoft Windows Bluetooth® Software		
Power Management	Microsoft Windows ACPI, and USBBus Support		



#### Technical Specifications - Networking and Communications

Certifications	FCC(47 CFR)Part 15C,Section 15.247 &15.249
Power Management Certifications	ETS300328,ETS300826
	LowVoltage Directive IEC950 UL,CSA,and CEMark
Bluetooth® Profiles Supported	BT4.1-ESR5/6/7 Compliance LELink Layer Ping
	LEDual Mode
	LELink Layer
	LELow Duty Cycle Directed Advertising
	LEL2CAPConnection Oriented Channels Train
	Nudging &Interlaced Scan
	BT4.2 ESR08 Compliance
	LESecure Connection-Basic/Full LEPrivacy 1.2 -
	Link Layer Privacy LE Privacy 1.2 - Extended
	Scanner Filter Policies
	LEData Packet Length Extension FAXProfile (FAX)
	Basic Imaging Profile (BIP)2 Headset Profile (HSP)
	Hands Free Profile (HFP)
	Advanced Audio Distribution Profile (A2DP)

# Intel® Wi-Fi 7 BE200 and Bluetooth® 5.4 wireless card, vPro® and NonvPro Module

The Intel® Wi-Fi 7 BE200 adapter is designed to support the upcoming IEEE 802.11be standard – Wi-Fi 71 technology and the Wi-Fi Alliance Wi-Fi 7 certification. Aligned with the upcoming IEEE 802.11be standard, the Intel® Wi-Fi 7 BE200 module supports these key features: 4096QAM and 320MHz channels resulting in 2.4X higher peak data rates4, Multi-link Operation (MLO - eMLSR), Multi-resource unit (Multi-RU) and Puncturing.

#### Intel® Wi-Fi 7 BE200 Module Technical Specifications

GENERAL	
Dimensions (H x W x D)	M.2 2230: 22mm x 30mm x 2.42mm (max) M.2 1216: 12mm x 16mm x 1.7 (+-0.1) mm
Weight	M.2 2230: 3.07+/-0.15g M.2 1216: 0.75+/-0.04g
Radio ON/OFF Control	Supported
Connector Interface	M.2: PCle*, USB
Operating Temperature (Amb	bient) 0°C to +50°C
Humidity Non-Operating	50% to 90% RH non-condensing (at temperatures of 25°C to 35°C)
Operating Systems	Microsoft* Windows 11*, Microsoft* Windows 10*, Linux*
Wi-Fi Alliance <sup>6</sup>	Wi-Fi 7 Technology support, Wi-Fi CERTIFIED* 6 with Wi-Fi 6E, Wi-Fi CERTIFIED* a/b/g/n/ac, WMM*, WMM*-Power Save, WPA3*, PMF*, Wi-Fi Direct*, Wi-Fi Agile Multiband*, Wi-Fi Location R2 HW readiness <sup>7</sup>
IEEE WLAN Standard	IEEE 802.11-2020 and select amendments (selected feature coverage) IEEE 802.11a, b, d, e, g, h, i, k, n, r, u, v, w, ac, ax, be; Fine Timing Measurement based on 802.11-2016, 802.11az HW readiness
Bluetooth®	Bluetooth® 5.4 (Ant. 1)
SECURITY FEATURES	



# HP Engage One Pro G2 All-In-One system 15.6", 19.5" and 23.8" Models

## QuickSpecs

#### Technical Specifications - Networking and Communications

Security Methods WPA3* personal and enterprise including WPA2* transition mode	
Authentication Protocols	802.1X EAP-TLS, EAP-TTLS/MSCHAPv2, PEAPv0 -MSCHAPv2 (EAP-SIM, EAP-AKA, EAP-AKA')
Encryption	128-bit AES-CCMP, 256-bit AES-GCMP
COMPLIANCE	
Regulatory	For a list of country approvals, please contact your local Intel representatives.
US Government	FIPS <sup>9</sup> 140-3
Product Safety	UL, C-UL, CB (62368-1)

Product Name	Model Number	Version
Intel® Wi-Fi 7 BE200	BE200NGW BE200D2W	Wi-Fi 7, 2x2, Bluetooth® 5.4, M.2 2230 Wi-Fi 7, 2x2, Bluetooth® 5.4, M.2 1216

Wi-Fi 7 (802.11be) WFA certification is not yet available. Intel® Wi-Fi 7 BE200 module will be delivered as a pre-certified solution.

802.11 wireless standard specifications, and require the use of similarly configured 802.11be wireless network routers.

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Tests document the performance of components on a particular test, in specific systems. Differences in hardware, software, or configuration will affect actual performance. Consult other sources of information to evaluate performance as you consider your purchase. For more complete information about performance and benchmark results, visit <a href="https://www.intel.com/benchmarks">www.intel.com/benchmarks</a>.

Estimated results were obtained prior to implementation of recent software patches and firmware updates intended to address exploits referred to as "Spectre" and "Meltdown". Implementation of these updates may make these results inapplicable to your device or system. No license (express or implied, by estoppel or otherwise) to any intellectual property rights is granted by this document.

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#### NFC NXP NPC300

**Dimensions (L x W** 17 x 10 x 2.0 mm **x H)** 



<sup>&</sup>lt;sup>2</sup> Name and features might change based on Bluetooth® SIG direction

<sup>&</sup>lt;sup>3</sup> "5 Gbps Wi-Fi 7 2x2 client speed" - is based on the current draft of the 802.11be specification, which specifies the theoretical maximum data rate for a 2x2 device that supports 320 MHz channels in the 6GHz band, with a 4096 QAM modulation is 5.76 Gbps. Based on an industry-standard efficiency assumption, the resulting estimated maximum over-the-air 2x2 client UDP throughput speed would be 5 Gbps

<sup>&</sup>lt;sup>4</sup>"2.4X higher peak data rates" Intel® Wi-Fi, 7 BE200 claims, are based on the comparison of the expected maximum theoretical data rates for similarly configured single radio Wi-Fi 7 (802.11be) and standard Wi-Fi 6 (802.11ax) Wi-Fi solutions as documented in current IEEE 802.11be spec and IEEE

<sup>&</sup>lt;sup>5</sup> Intel® vPro® Technology is sophisticated and requires setup and activation. Availability of features and results will depend upon the setup and configuration of your hardware, software, and IT environment. To learn more, visit: <a href="http://www.intel.com/technology/vpro.">http://www.intel.com/technology/vpro.</a>

<sup>&</sup>lt;sup>6</sup> Support of Wi-Fi Alliance certifications is OS-dependent.

<sup>&</sup>lt;sup>7</sup> IEEE 802.11az hardware readiness per expected Wi-Fi Location R2 feature support and based on draft 2.1 of the IEEE802.11az amendment and is subject to change.

<sup>&</sup>lt;sup>8</sup> Some security solutions may not be supported by your device operating system and/or by your device manufacturer or may require additional hardware (e.g., UICC - SIM card). Check with your device manufacturer for details on availability.

<sup>9</sup> Pre-certified

#### Technical Specifications - Networking and Communications

Chipset NPC300 System interface I2C

NFC RF standards ISO/IEC 14443 A

> ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2 NFC Forum Support

Reader (PCD-VCD)

ISO/IEC 14443 A Mode(1) ISO/IEC 14443 B

ISO/IEC 15693 MIFARE 1K MIFARE 4K MIFARE DESFire

FeliCa

Jewel and Topaz cards

**Card Emulation** ISO/IEC 14443 A (PICC-VICC) Mode(1) ISO/IEC 14443 B and B'

> **MIFARE** FeliCa

Frequency 13.56 MHz

**NFC Modes** 

Supported Reader/Writer, Peer-to-Peer

Raw RF Data Rates 106, 212, 424, 848 kbps

Operating

temperature 0°C to 70°C Storage temperature -20°C to 125°C Humidity 10-90% operating

5-95% non-operating

**Supply Operating** 

voltage 4.35 to 5.25 Volts 1.8V or 3.3V I/O Voltage

**Power Consumption** Booster enable, VBAT=3.3V,

> VCC BOOST = **Polling** 7.3 mA 5V) Mode Power Detected Test Total 283.8 mA

Consumption, **Typical** 

Detected Test Total 288.8 mA

Tag Type 2 Net Module 241.8 mA Detected Test Total 287.7 mA Tag Type 3 Net Module 240.7 mA

Net Module 236.8 mA

Detected Test Total 282.3 mA Tag Type 4 Net Module 235.3 mA

**Antenna** Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna matching is

Tag Type 1

external to module.



### Technical Specifications - Audio/Multimedia

### **High-Definition Audio**

Engage One System Audio (Realtek ALC3247-CG)

Type Integrated

HD Stereo CodecHigh-Definition Audio codecInternal Speaker Amplifier4-channel DAC, 4-channel ADC,

and an integrated stereo Class-D Speaker Amplifier

SamplingSampling frequency=48kHzAnalog AudioYes, Audio Jack support CTIA type# of Channels on line-outStereo (Left & Right channels)

Internal speaker Yes

Microphone Yes, stereo digital microphone input with Realtek proprietary Acoustic Echo

Cancellation (AEC), Beam Forming (BF), and Noise Suppression (NS) technology,

significantly

improving voice quality for PC VoIP applications

Maximum Power Output 2W per channel at 5V power supply

**Headphone** yes

### Technical Specifications - Integrated Camera

#### 1.2 Basic Specification

Camera	5MP+IR camera
Sensor	RGB: 1/4.7" 5M CMOS (OV05C) IR: 1/10.5" 400x400 CMOS (OV6211)
Effective Pixel	RGB: 2880x1800 IR: 400x400
Output Image Size	RGB : Up to 2880x1800 IR : Up to 400x400
Output Format	YUY2, MJPEG
Frame Rate	RGB: 30fps @ MJPG 5M IR: 30fps @Y8 400x400
Lens Structure	RGB: F/2.0, 4P IR: F/2.0, 3P
Outside Dimension	96±0.2 x 5±0.1 x 3.38±0.15 (unit: mm) (Including Lens + PCB + adhesive tape)
PCB thickness	0.3±0.08mm
Interface	USB 2.0
LED Color	White



### Technical Specifications - Integrated Camera

#### **RGB: HP 5MP Camera**

#### IR: HP IR Camera

#### **Features**

- Automatic image control
- ✓ Automatic / Manually Exposure Control
- ✓ Automatic / Manually White Balance Control
- ✓ Automatic Gain Control
- ✓ Face AE
- ✓ Temporal Noise Reduction
- ✓ High Dynamic Range
- ✓ Human Presence Detection
- ✓ Low Light Compensation
- ✓ Power Line Flicker Compensation (default@ 60Hz)
- ✓ Gain
- Resolution Support for Still/Motion Image

- > Image Quality Control (Adjust Manually)
- ✓ Brightness
- ✓ Contrast
- ✓ Hue
- ✓ Saturation
- √ Sharpness
- ✓ Gamma
- ✓ Backlight Compensation



#### Technical Specifications - Power

#### **POWER**

Power Supply 280Watt Smart PFC Standard Barrel 7.4mm Straight 1.8m C14 SR-S; 89% efficiency (advance

hub)

230Watt Smart PFC Slim Barrel 7.4mm Right Angle; 89% efficiency (Column hub & VESA hub)

150 Watt Smart PFC Slim Barrel 7.4mm Straight, 89% efficiency (hubless)

Operating Voltage Range90V~265VACRated Voltage Range100V~240ACRated Line Frequency50~60HZOperating Line Frequency47~63HZ

Range

**Rated Input Current** <2.4A RMS/280W, <3.52A/230W

Power Supply Fan N/A

ENERGY STAR® Compliant ENERGY STAR® certified configurations available and EPEAT® registered \*

Power Cord Length 1.8m

NOTE: Power supply meets ENERGY STAR® compliance in conjunction with a select range of

processors and modules.

\*Energy Star in under testing & in process of certification at the time this document is written

#### **WEIGHTS & DIMENSIONS**

NOTE: Weight and dimensions below do not include MSR, Biometric Reader, Webcam, or CFD.



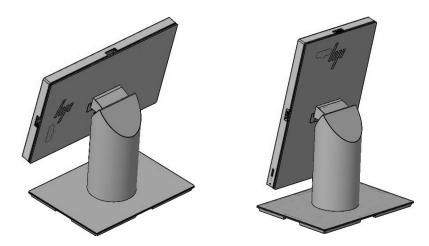


Head Unit-15.6"			
	Metric	US	
Head Unit-15.6" Dimensions (Landscape)			
Height [mm/in]	26.4	1.0	
Width [mm/in]	397.6	15.7	
Depth [mm/in]	241.0	9.5	
Volume (Liters/cubic inches)	2.5	154.35	
Head Unit-15.6" Dimensions (Portrait)			

### Technical Specifications - Power

Height [mm/in]	26.4	1.0
Width [mm/in]	397.6	15.7
Depth [mm/in]	241.0	9.5
Volume (Liters/cubic inches)	2.5	154.35
Head Unit-15.6" Weight (Landscape)		
[kg/lb]	3.37	7.4
Head Unit-15.6" Weight (Portrait)		
[kg/lb]	3.35	7.4



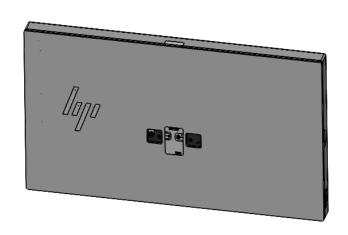


Head Unit-15.6"		
	Metric	US
Landscape dimensions (when working angle is 12 degree)		
Height [mm/in]	365.8	14.4
Width [mm/in]	391.6	15.4
Depth [mm/in]	220.0	8.7
Volume (Litres/cubic inches)	31.5	1923.13
Portrait dimensions (when working angle is 12 degree)		
Height [mm/in]	439.4	17.3
Width [mm/in]	305.0	12.0
Depth [mm/in]	220.0	8.7
Volume (Liters/cubic inches)	29.5	1799.21
Head Unit-15.6" Weight (Landscape) + Gordo Stand		
[kg/lb]	6.70	14.8
Head Unit-15.6" Weight (Portrait)+ Gordo Stand		
[kg/lb]	6.70	14.8





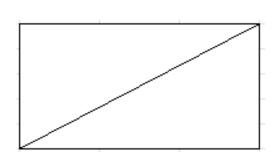
Head Unit-15.6"			
	Metric	US	
Landscape dimensions (when working angle is 40~140 degree)			
Height [mm/in]	346.3	13.6	
Width [mm/in]	391.6	15.4	
Depth [mm/in]	220.0	8.7	
Volume (Liters/cubic inches)	29.8	1820.61	
Portrait dimensions (when working angle is 40~140 degree)			
Height [mm/in]	404.0	15.9	
Width [mm/in]	305.0	12.0	
Depth [mm/in]	271.8	10.7	
Volume (Liters/cubic inches)	33.5	2043.76	
Head Unit-15.6" Weight (Landscape)+ Gordo Stand			
[kg/lb]	6.70	14.8	
Head Unit-15.6" Weight (Portrait)+ Gordo Stand			
[kg/lb]	6.70	14.8	





Head Unit-19.5"		
	Metric	US
Head Unit-19.5" Dimensions (Landscape)		
Height [mm/in]	29.4	1.2
Width [mm/in]	494.8	19.5
Depth [mm/in]	292.6	11.5
Volume (Litres/cubic inches)	4.3	259.75
Head Unit-19.5" Dimensions (Portrait)		
Height [mm/in]	29.4	1.2
Width [mm/in]	488.8	19.2
Depth [mm/in]	292.6	11.5
Volume (Litres/cubic inches)	4.2	256.60
Head Unit-19.5" Weight (Landscape)		
[kg/lb]	5.70	12.6
Head Unit-19.5" Weight (Portrait)		
[kg/lb]	5.69	12.5





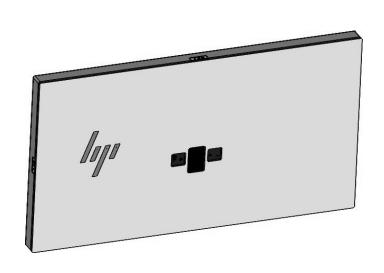
Head Unit-19.5"		
	Metric	US
Landscape dimensions (when working angle is 12 degree)		
Height [mm/in]	391.6	15.4
Width [mm/in]	488.8	19.2
Depth [mm/in]	220.0	8.7
Volume (Litres/cubic inches)	42.1	2569.78
Portrait 19.5" does not support 12 degrees		
Height [mm/in]		
Width [mm/in]		
Depth [mm/in]		
Volume (Litres/cubic inches)		
Head Unit-19.5" Weight (Landscape)		
[kg/lb]	8.80	19.4
Head Unit-19.5" Weight (Portrait)		
[kg/lb]		

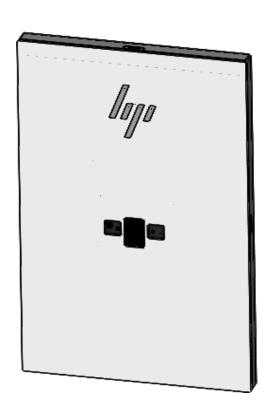






Head Unit-19.5"		
	Metric	US
Landscape dimensions (when working angle is 40~140 degree)		
Height [mm/in]	368.0	14.5
Width [mm/in]	488.8	19.2
Depth [mm/in]	239.5	9.4
Volume (Litres/cubic inches)	43.1	2628.96
portrait dimensions (when working angle is 40~140 degree)		
Height [mm/in]	443.2	17.4
Width [mm/in]	305.0	12.0
Depth [mm/in]	336.5	13.2
Volume (Litres/cubic inches)	45.5	2775.77
Head Unit-19.5" Weight (Landscape)+Gordo Stand		
[kg/lb]	8.80	19.4
Head Unit-19.5" Weight (Portrait)+Gordo Stand		
[kg/lb]	8.80	19.4

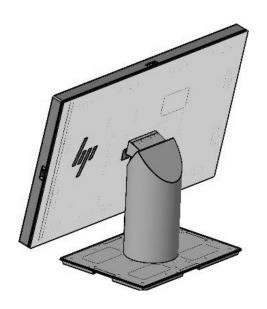


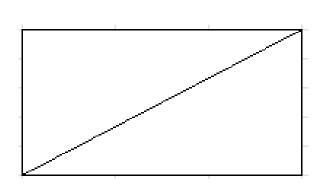


Head Unit-23.8"		
	Metric	US
Head Unit-23.8" Dimensions (Landscape)		
Height [mm/in]	29.4	1.2
Width [mm/in]	576.4	22.7
Depth [mm/in]	339.9	13.4
Volume (Litres/cubic inches)	5.8	351.50
Head Unit-23.8" Dimensions (Portrait)		
Height [mm/in]	29.4	1.2
Width [mm/in]	570.4	22.5
Depth [mm/in]	339.9	13.4
Volume (Litres/cubic inches)	5.7	347.84
Head Unit-23.8" Weight (Landscape)		
[kg/lb]	6.80	15.0
Head Unit-23.8" Weight (Portrait)		

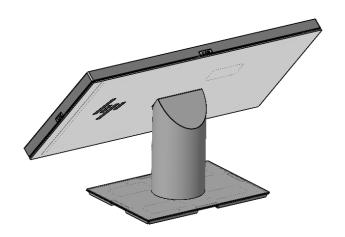


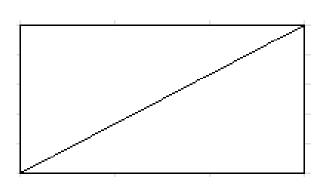
[kg/lb]	6.79	15.0





Head Unit-23.8"		
	Metric	US
Landscape dimensions (when working angle is 12 degree)		
Height [mm/in]	414.7	16.3
Width [mm/in]	570.4	22.5
Depth [mm/in]	220.0	8.7
Volume (Litres/cubic inches)	52.0	3175.67
Portrait 23.8" does not support 12 degrees		
Height [mm/in]		
Width [mm/in]		
Depth [mm/in]		
Volume (Litres/cubic inches)		
Head Unit-19.5" Weight (Landscape)		
[kg/lb]	10.60	23.4
Head Unit-19.5" Weight (Portrait)		
[kg/lb]		





Head Unit-23.8"		
	Metric	US
Landscape dimensions (when working angle is 40~140 degree)		
Height [mm/in]	386.2	15.2
Width [mm/in]	570.4	22.5
Depth [mm/in]	254.7	10.0
Volume (Litres/cubic inches)	56.1	3423.89
Portrait does not support 40~140 degree		
Height [mm/in]		
Width [mm/in]		
Depth [mm/in]		
Volume (Litres/cubic inches)		
Head Unit-19.5" Weight (Landscape)+ Gordo Stand		
[kg/lb]	10.60	23.4
Head Unit-19.5" Weight (Portrait)+ Gordo Stand		
[kg/lb]		

### **Pro Stand**







Marketting Name	Pro Stand		Advanced Stand	
	Metric	US	Metric	US
Stand Dimensions(with Stability Base)				
Height [mm/in]	207.05	8.15	243.3	9.6
Width [mm/in]	305	12	305	12
Depth [mm/in]	220	8.7	220	8.7
Stand Dimensions (without Stability Base)				
Height [mm/in]	195.35	7.69	231.5	9.1
Width [mm/in]	105	4.13	110	4.3
Depth [mm/in]	105	4.13	110	4.3
Stand Weight with Stability Base				
Weight [kg/lb]	2.35	5.2	3.1	6.8
Stand Weight without Stability Base				
Weight [kg/lb]	0.95	2.1	1.7	3.7

Engage One Pro G2 Advanced Fanless hub		
	Metric	US
Hub Dimensions (with Lifted Hub surround)		
Height [mm/in]	220.3	8.7
Width [mm/in]	305.3	12.0
Depth [mm/in]	36.7	1.4
Hub Dimensions (Without Lifted Hub surround)		
Height [mm/in]	100.0	3.9
Width [mm/in]	275.0	10.8
Depth [mm/in]	28.5	1.1
Hub Weight with Lifted Hub surround		
Weight [kg/lb]	1.00	2.2
Hub Weight (without Spring Hub surround) or Possum Hub Only		
Weight [kg/lb]	0.69	1.5

Engage One Pro G2 Advanced Fanless hub		
	Metric	US
Hub Dimensions (with U-shape Hub surround)		
Height [mm/in]	220.3	8.7
Width [mm/in]	305.3	12.0
Depth [mm/in]	36.7	1.4
Hub Dimensions (Without U-shape Hub surround)		
Height [mm/in]	100.0	3.9
Width [mm/in]	275.0	10.8
Depth [mm/in]	28.5	1.1
Hub Weight with Normal Hub surround		
Weight [kg/lb]	1.00	2.2
Hub Weight (without Spring Hub surround) or Possum Hub Only		
Weight [kg/lb]	0.69	1.5



HP Engage One Pro G2 VESAhub and Hubless USB-A		
Metric	US	
150.0	5.9	
125.0	4.9	
24.4	1.0	
0.54	1.20	
	Metric 150.0 125.0 24.4	

HP Engage One Pro G2 Slim VESAMount			
	Metric	US	
Dimensions			
Height [mm/in]	120.0	4.7	
Width [mm/in]	120.0	4.7	
Depth [mm/in]	10.5	0.4	
Weight			
[kg/lb]	0.23	0.51	

Engage Pro G2 Advanced Stand			
	Metric	US	
Stand Dimensions(with Stability Base)			
Height [mm/in]	243.3	9.6	
Width [mm/in]	305.0	12.0	
Depth [mm/in]	220.0	8.7	
Stand Dimensions (without Stability Base)			
Height [mm/in]	231.5	9.1	
Width [mm/in]	110.0	4.3	
Depth [mm/in]	110.0	4.3	
Stand Weight with Stability Base (without wombat)			
Weight [kg/lb]	3.13	6.9	



Stand Weight without Stability Base (without wombat)		
Weight [kg/lb]	1.70	3.7

Engago Pro CO Stand				
Engage Pro G2 Stand				
	Metric	US		
Stand Dimensions(with Stability Base)				
Height [mm/in]	239.3	9.0		
Width [mm/in]	308.0	13.0		
Depth [mm/in]	220.0	8.7		
Stand Dimensions (without Stability Base)				
Height [mm/in]	239.3	9.0		
Width [mm/in]	110.0	4.3		
Depth [mm/in]	110.0	4.3		
Stand Weight with Stability Base (without wombat)				
Weight [kg/lb]	3.13	6.9		
Stand Weight without Stability Base (without wombat)				
Weight [kg/lb]	0.91	2		



### Technical Specifications - Miscellaneous Features

### System Summary Dimension Matrix Summary table

Display Heads Only	Width (Horizontal)[mm]	Height (Vertical)[mm]	Thickness [mm]
15.6 Landscape	397.6	241.0	26.4
19.5 Landscape	494.8	292.6	29.4
23.8 Landscape	576.4	339.9	29.4
15.6 Portrait	241.0	391.6	26.4
19.5 Portrait	292.6	488.8	29.4
23.8 Portrait- Slim VESA only*	339.9	570.4	29.4

## **NOTE:** \*23.8" Portrait can only be support with SLIM VESA mount, not configurable with any Column stand, not configurable with column hub

Width [mm]	Depth [mm]	Thickness [mm]
305.0	220.0	11.7
225.0	222	00.7
305.0	220.0	38.7
305.0	220.0	27.0
		305.0 220.0 305.0 220.0

10" CFD module			
	Metric	US	
10" CFD Dimensions			
Height [mm/in]	170.2	6.7	
Width [mm/in]	246.2	9.7	
Depth [mm/in]	18.0	0.7	



#### Technical Specifications - Miscellaneous Features

Weight(Without cable) [kg/lb]	1.00	2.20
-------------------------------	------	------

#### MISCELLANEOUS FEATURES

#### **Management Features**

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
- Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel® Wired for Management support; industry wide initiative to make Intel® architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

#### HP Point of Sale Diagnostics UEFI:

• This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support

#### Serviceability Features:

- System/Emergency ROM
- Flash ROM
- Flash Recovery with Video Configuration Record Software
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- Clear CMOS Button
- · Color coordinated cables and connectors
- Front power switch
- System memory can be upgraded without removing the system board or any internal components

#### Interpreting System Validation Diagnostic Front Panel LEDs and Audible Codes

During the system validation phase that occurs at system startup, the BIOS validates the functionality of the following subsystems and conditions:

- AC adapter
- System board power
- Processor failure
- BIOS corruption
- Memory failure
- Graphics failure
- System board failure
- BIOS authentication failure

If an error is detected, specific patterns of long and short blinks, accompanied by long and short beeps (where applicable) are used to identify the error. These patterns 48esi make up a two part code:

- Major the category of the error
- Minor the specific error within the category

1111	NOTE:	Single beep/blink codes are not used.



### Technical Specifications - Miscellaneous Features

Number of long beeps/blinks	Error category
1	Not used
2	BIOS
3	Hardware
4	Thermal
5	System board

Patterns of blink/beep codes are determined by using the following parameters:

- 1 second pause occurs after the last major blink.
- 2 second pause occurs after the last minor blink.
- Beep error code sequences occur for the first 5 iterations of the pattern and then stop.
- Blink error code sequences continue until the computer is unplugged or the power button is pressed.



NOTE: Not all diagnostic lights and audible codes are available on all models.

The red LED blinks to represent the major error category (long blinks). The white LED blinks to represent the minor error category (short blinks). For example, '3.5' indicates 3 long red blinks and 5 short white blinks to communicate the processor is not detected.

Category	Major/minor code	Description
BIOS	2.2	The main area (DXE) of BIOS has become corrupted and there is no recovery binary image available.
	2.3	The embedded controller policy requires the user to enter a key sequence.
	2.4	The embedded controller is checking or recovering the boot block.
Hardware	3.2	The embedded controller has timed out waiting for BIOS to return from memory initialization.
	3.3	The embedded controller has timed out waiting for BIOS to return from graphics initialization.
	3.4	The system board displays a power failure (crowbar).*
	3.5	The processor is not detected.*
	3.6	The processor does not support an enabled feature.
Thermal	4.2	A processor over temperature condition has been detected.*
	4.3	An ambient temperature over temperature condition has been detected.
	4.4	An MXM over temperature condition has been detected.
System board	5.2	The embedded controller cannot find valid firmware.
	5.3	The embedded controller has timed out waiting for the BIOS.
	5.4	The embedded controller has timed out waiting for BIOS to return from system board initialization.



### Technical Specifications - Miscellaneous Features

5.5 The embedded controller rebooted the system after a possible lockup condition had been detected through the use of a System Health Timer, Automated System Recovery Timer, or other

### TEMPERATURE, HUMIDITY, ALTITUDE

Temperature	Operating	50° to 104° F (10 to 40° C)
	Non-operating	-22° to 149° F (-30°to 65° C)
Humidity	Operating	20%-85% relative humidity at max inlet temperature
	Non Operating	20%-85% relative humidity at max inlet temperature
Shock	Operating	40g, six surfaces
	Non Operating	30g, six surfaces
Vibration	Operating	2-g peak acceleration
	Non Operating	3-g peak acceleration
Altitude	Operating	0 to 10,000 ft (3,048 m)
(unpressurized)	Non-operating	0 to 30,000 ft (9,144 m)



 $<sup>^{\</sup>ast}$  Indicates hardware triggered event; all other events are controlled by the BIOS.

#### Technical Specifications - Environmental

#### **ENVIRONMENTAL & INDUSTRY**

#### **Environmental Data**

#### HP Engage One Pro G2 AiO System Model 15.6"

## Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT® Gold registered in the United States. See http://www.epeat.net for registration status in your country.
- China Energy Conservation Program (CECP)
- China State Environmental Protection Administration (SEPA)
- Taiwan Green Mark
- Korea Eco-label
- Japan PC Green label\*

\*Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit www.epeat.net for more information

## Sustainable Impact Specifications

- Product Carbon Footprint
- At least 50% ocean bound plastic in the (CPU Fan and System Fan)and 5% ocean bound plastic in the (Speaker)<sup>1</sup>
- At least 3% ITE-Derived closed loop plastic<sup>2</sup>
- At least 70% post-consumer recycled plastic<sup>2</sup>
- At least 40% recycled metal<sup>3</sup>
- External Power Supply 90% Efficiency
- Low Halogen<sup>4</sup>
   100% of HP paper-based packaging is from recycled or certified sustainable sources<sup>5</sup>

#### **System Configuration**

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Engage One Pro model is based on a typically configured system featuring an SSD, a high efficiency power supply, and a Microsoft Windows® operating system.

#### Energy Consumption (in accordance with US ENERGY STAR® test method

ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	10.30 W	10.69 W	10.25 W
Normal Operation (Long idle)	5.18 W	5.16 W	5.12 W
Sleep	1.81 W	1.84 W	1.81 W
Off	0.92 W	0.94 W	0.91 W

#### Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation\* 115VAC, 60Hz 230VAC, 50Hz 100VAC, 50Hz



#### **Technical Specifications - Environmental**

Normal Operation (Short idle)	35 BTU/hr	37 BTU/hr	35 BTU/hr
Normal Operation (Long idle)	18 BTU/hr	18 BTU/hr	18 BTU/hr
Sleep	6 BTU/hr	6 BTU/hr	6 BTU/hr
Off	3 BTU/hr	3 BTU/hr	3 BTU/hr

<sup>\*</sup> Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour

<b>Declared Noise Emissions</b>
(in accordance with
ISO 7779 and ISO 9296)

Typically Configured - Idle Fixed Disk - Random writes Optical Drive - Sequential reads

Longevity and Upgrading

Sound Power (L <sub>WAd</sub> , bels)	Sound Pressure (L <sub>pAm</sub> , decibels)	
2.6	23.2	
2.7	23.7	
N/A	N/A	

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

#### Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the <Gold>
  level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product is 95.6% recycle-able when properly disposed of at end of life.

#### **Packaging Materials**

External:	PAPER/Corrugated	1309 g
	PAPER/Molded Pulp	490 g
Internal:	PLASTIC/Polyethylene Expanded - EPE	154 g
	PLASTIC/Polyethylene high density - HDPE	14 g
	PLASTIC/Polyethylene low density - LDPE	4

The plastic packaging material contains at least 97% recycled content.

**RoHS Compliance** 

The corrugated paper packaging materials contains at least 91.7% recycled content. HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the

development of related legislation in Europe, as well as China, India, and Vietnam.

We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional

substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.

#### Technical Specifications - Environmental

We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.

To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

#### Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Notes: \* EPE foam packaging material is considered "recycled" pre-Consumer. The scrap or waste EPE material from the manufacturing process of these EPE foam pieces are reintroduced into the manufacturing process.



#### Technical Specifications - Environmental

#### **Packaging Usage**

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

## End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to:

https://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c05403198 or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: HP Product Disassembly Instruction Website. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

## HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

- Sustainable Impact Report
  - https://h20195.www2.hp.com/v2/GetDocument.aspx?docname=c0604084
- Eco-label certifications
  - https://www.hp.com/us-en/sustainable-impact/documentreports.html#filters\_documents\_reports-=document\_typetype\_energy\_star,type\_epeat,type\_tcolSO
- ISO 14001 certificates
  - https://h20195.www2.hp.com/v2/GetDocument.aspx?docname=c04777932

#### **Footnotes**

- 1. Percentage of ocean-bound plastic contained in each component varies by product. Ocean Bound plastic is expressed as a percentage of the total weight plastic. Ocean Bound plastic is based on the definition set by the UL2809 standard.
- 2. Recycled plastic is expressed as a percentage of the total weight plastic. Post-consumer recycled is based on the definition set in the EPEAT standard for computers, IEEE 1680.1-2018 standard.
- 3. Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams.
- 4. External power supplies, WWAN modules, power cords, cables and peripherals excluded. Service parts obtained after purchase may not be Low Halogen.
- 5. HP paper and fiber-based packaging for PCs, displays, home and office print, and supplies is reported by suppliers as recycled or certified, with a minimum of 97% by volume verified by HP. Packaging is the box that comes with the product and all paper-based materials inside the box. Packaging for personal systems



#### Technical Specifications - Environmental

accessories and spare parts is not included. Plastic cushions are made from >90% recycled plastic.

#### HP Engage One Pro G2 AiO System Model 19.5"

## Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT® Gold registered in the United States. See http://www.epeat.net for registration status in your country.
- China Energy Conservation Program (CECP)
- China State Environmental Protection Administration (SEPA)
- Taiwan Green Mark
- Korea Eco-label
- Japan PC Green label\*

\*Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit www.epeat.net for more information

## Sustainable Impact Specifications

- Product Carbon Footprint
- At least 50% ocean bound plastic in the (CPU Fan and System Fan)and 5% ocean bound plastic in the (Speaker)<sup>1</sup>
- At least 70% post-consumer recycled plastic<sup>2</sup>
- At least 40% recycled metal<sup>3</sup>
- External Power Supply 90% Efficiency
- Low Halogen<sup>4</sup>
- 100% of HP paper-based packaging is from recycled or certified sustainable sources<sup>5</sup>

#### **System Configuration**

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Engage One Pro model is based on a typically configured system featuring an SSD, a high efficiency power supply, and a Microsoft Windows® operating system.

### Energy Consumption (in accordance with US

ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	17.27 W	17.06 W	16.91 W
Normal Operation (Long idle)	5.42 W	5.41 W	5.45 W
Sleep	1.52 W	1.55 W	1.52 W
Off	0.94 W	0.96 W	0.94 W

#### Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation\* 115VAC, 60Hz 230VAC, 50Hz 100VAC, 50Hz



#### **Technical Specifications - Environmental**

Normal Operation (Short idle)	59 BTU/hr	58 BTU/hr	58 BTU/hr
Normal Operation (Long idle)	19 BTU/hr	19 BTU/hr	19 BTU/hr
Sleep	5 BTU/hr	5 BTU/hr	5 BTU/hr
Off	3 BTU/hr	3 BTU/hr	3 BTU/hr

<sup>\*</sup> Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour

De	eclo	ıred N	loise E	miss	sions
(in accordance with					
ISO 7779 and ISO 9296)					
_					

Typically Configured - Idle Fixed Disk - Random writes Optical Drive - Sequential reads

Longevity and Upgrading

Sound Power Sound Pressure (L<sub>WAd</sub>, bels) (L<sub>pAm</sub>, decibels)

2.6 16.3 2.6 16.3 2.6 17.0

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

#### Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the <Gold>
  level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product is 96.9% recycle-able when properly disposed of at end of life.

#### **Packaging Materials**

External: PAPER/Corrugated 1389 g

PAPER/Molded Pulp 699 g

Internal: PLASTIC/Polyethylene Expanded - EPE 308 g

PLASTIC/Polyethylene high density - HDPE 25 g
PLASTIC/Polyethylene low density - LDPE 4

The plastic packaging material contains at least 97% recycled content.

The corrugated paper packaging materials contains at least 96% recycled content.

#### **RoHS Compliance**

HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.

We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.

#### Technical Specifications - Environmental

We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.

To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

#### Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Notes: \* EPE foam packaging material is considered "recycled" pre-Consumer. The scrap or waste EPE material from the manufacturing process of these EPE foam pieces are reintroduced into the manufacturing process.



#### **Technical Specifications - Environmental**

#### Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

## End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to:

https://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c05403198 or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: HP Product Disassembly Instruction Website. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

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- Eco-label certifications
  - https://www.hp.com/us-en/sustainable-impact/documentreports.html#filters\_documents\_reports-=document\_typetype\_energy\_star,type\_epeat,type\_tcolSO
- ISO 14001 certificates
  - https://h20195.www2.hp.com/v2/GetDocument.aspx?docname=c04777932

#### **Footnotes**

- 1. Percentage of ocean-bound plastic contained in each component varies by product. Ocean Bound plastic is expressed as a percentage of the total weight plastic. Ocean Bound plastic is based on the definition set by the UL2809 standard.
- 2. Recycled plastic is expressed as a percentage of the total weight plastic. Post-consumer recycled is based on the definition set in the EPEAT standard for computers, IEEE 1680.1-2018 standard.
- 3. Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams.
- 4. External power supplies, WWAN modules, power cords, cables and peripherals excluded. Service parts obtained after purchase may not be Low Halogen.
- 5. HP paper and fiber-based packaging for PCs, displays, home and office print, and supplies is reported by suppliers as recycled or certified, with a minimum of 97% by volume verified by HP. Packaging is the box that comes with the product and all paper-based materials inside the box. Packaging for personal systems



#### Technical Specifications - Environmental

accessories and spare parts is not included. Plastic cushions are made from >90% recycled plastic.

#### HP Engage One Pro G2 AiO System Model 23.8"

## Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT® Gold registered in the United States. See http://www.epeat.net for registration status in your country.
- China Energy Conservation Program (CECP)
- China State Environmental Protection Administration (SEPA)
- Taiwan Green Mark
- Korea Eco-label
- Japan PC Green label\*

\*Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit www.epeat.net for more information

## Sustainable Impact Specifications

- Product Carbon Footprint
- At least 50% ocean bound plastic in the (CPU Fan and System Fan)and 5% ocean bound plastic in the (Speaker)<sup>1</sup>
- At least 70% post-consumer recycled plastic<sup>2</sup>
- At least 35% recycled metal<sup>3</sup>
- External Power Supply 90% Efficiency
- Low Halogen<sup>4</sup>
- 100% of HP paper-based packaging is from recycled or certified sustainable sources<sup>5</sup>

#### **System Configuration**

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Engage One Pro model is based on a typically configured system featuring an SSD, a high efficiency power supply, and a Microsoft Windows® operating system.

# Energy Consumption (in accordance with US

ENERGY STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	21.73 W	21.91 W	21.42 W
Normal Operation (Long idle)	6.18 W	6.35 W	6.13 W
Sleep	1.62 W	1.62 W	1.61 W
Off	0.91 W	0.95 W	0.91 W

#### Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation\* 115VAC, 60Hz 230VAC, 50Hz 100VAC, 50Hz



### **Technical Specifications - Environmental**

Normal Operation (Short idle)	74 BTU/hr	75 BTU/hr	73 BTU/hr
Normal Operation (Long idle)	21 BTU/hr	22 BTU/hr	21 BTU/hr
Sleep	6 BTU/hr	6 BTU/hr	6 BTU/hr
Off	3 BTU/hr	3 BTU/hr	3 BTU/hr

<sup>\*</sup> Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour

Declared Noise Emissions
(in accordance with
ISO 7779 and ISO 9296)

Typically Configured - Idle Fixed Disk - Random writes Optical Drive - Sequential reads

Longevity and Upgrading

Sound Power Sound Pressure (L<sub>WAd</sub>, bels) (L<sub>pAm</sub>, decibels)

2.716.12.716.12.716.2

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

#### Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680.1 (EPEAT) standard at the <Gold>
  level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product is 97.5% recycle-able when properly disposed of at end of life.

### **Packaging Materials**

External: PAPER/Corrugated 1389 g

PAPER/Molded Pulp 699 g

Internal: PLASTIC/Polyethylene Expanded - EPE 308 g

PLASTIC/Polyethylene high density - HDPE 25 g
PLASTIC/Polyethylene low density - LDPE 4

The plastic packaging material contains at least 97% recycled content.

### RoHS Compliance

The corrugated paper packaging materials contains at least 96% recycled content.

HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.

We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.

#### Technical Specifications - Environmental

We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.

To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

#### Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Notes: \* EPE foam packaging material is considered "recycled" pre-Consumer. The scrap or waste EPE material from the manufacturing process of these EPE foam pieces are reintroduced into the manufacturing process.



#### Technical Specifications - Environmental

#### Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

## End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to:

https://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c05403198 or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: HP Product Disassembly Instruction Website. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

## HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

- Sustainable Impact Report
  - https://h20195.www2.hp.com/v2/GetDocument.aspx?docname=c0604084
- Eco-label certifications
  - https://www.hp.com/us-en/sustainable-impact/documentreports.html#filters\_documents\_reports-=document\_typetype\_energy\_star,type\_epeat,type\_tcolSO
- ISO 14001 certificates
  - https://h20195.www2.hp.com/v2/GetDocument.aspx?docname=c04777932

#### **Footnotes**

- 1. Percentage of ocean-bound plastic contained in each component varies by product. Ocean Bound plastic is expressed as a percentage of the total weight plastic. Ocean Bound plastic is based on the definition set by the UL2809 standard.
- Recycled plastic is expressed as a percentage of the total weight plastic. Postconsumer recycled is based on the definition set in the EPEAT standard for computers, IEEE 1680.1-2018 standard.
- 3. Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams.
- 4. External power supplies, WWAN modules, power cords, cables and peripherals excluded. Service parts obtained after purchase may not be Low Halogen.
- 5. HP paper and fiber-based packaging for PCs, displays, home and office print, and supplies is reported by suppliers as recycled or certified, with a minimum of 97% by volume verified by HP. Packaging is the box that comes with the product and all paper-based materials inside the box. Packaging for personal systems



# HP Engage One Pro G2 All-In-One system 15.6", 19.5" and 23.8" Models

# QuickSpecs

**Technical Specifications - Environmental** 

accessories and spare parts is not included. Plastic cushions are made from >90% recycled plastic.



HP Engage One After Market Option Matrix

### HP Engage One Pro Advance Hubs & cable AMOs

AMO Part No. Description

9YH40AA#xxx HP Engage One Pro G2 Adv Fan-less Hub\*

156N6AA#xxx HP Engage One Pro G2 Adv Fan-less Hub White\*

\*Included 280W PSU/1.8M cord, need one of the separate cable below

2Z8M9AAHP Engage One Pro G2 2m USB-C® cable black2Z8N0AAHP Engage One Pro G2 0.5m USB-C® cable black2Z8N2AAHP Engage One Pro G2 2m USB-C® cable gray2Z8N1AAHP Engage One Pro G2 0.5m USB-C® cable gray

201A2AA HP Engage One Pro G2 Column/ VESA hub to Advance hub 2m black 201A1AA HP Engage One Pro G2 Column/ VESA hub to Advance hub 0.5m black

316D6AA HP Engage One Pro G2 Column/ VESA hub to Ad hub 2m gray 316D7AA HP Engage One Pro G2 Column/ VESA hub to Ad hub 0.5m gray

### HP Engage One Pro G2 VESAHubs & cable AMOs

AMO Part No. Description

9YH42AA#xxx Engage One Pro VESAHub\*\*

#### Additional Cable available to connect the Column hub or the VESA hub to the Advance hub below

201A2AA HP Engage One Pro G2 Column/VESA hub to Advance hub 2m black 201A1AA HP Engage One Pro G2 Column/VESA hub to Advance hub 0.5m black

316D6AA HP Engage One Pro G2 Column/VESA hub to Ad hub 2m gray 316D7AA HP Engage One Pro G2 Column/VESA hub to Ad hub 0.5m gray

## HP Engage One Pro G2 Mounting Option AMOs

AMO Part No. Description

1A4E7AA Engage One Pro Slim VESA

326R7AA Engage One Pro Slim VESAWhite

9YH43AA Engage One Pro U-shaped Adapter

156N7AA Engage One Pro U-shaped Adapter White

1A4E5AA HPEngage One Pro G2 AiOStability Plate



<sup>\*\*</sup>Included 230WPSU/ 1.8Mcord &cable

### HP Engage One After Market Option Matrix

1A4E6AA HPEngage One Pro G2 AiOStability Plate White
2W7M4AA Engage One Pro Flexible Pole Single Mount
2W7M3AA Engage One Pro Flexible Back-to-Back Bracket
9YH51AA Engage One Pro Undercounter Mount

## HP Engage One Pro G2 Mounting Option AMOs

AMO Part No. Description

2W7M4AA Engage One Pro Flexible Pole Single Mount
2W7M3AA Engage One Pro Flexible Back-to-Back Bracket

## HP Engage One Pro G2 Customer Facing Displays (CFDs)

AMO Part No.	Description
B11G3AA	HP Engage 6.9 inch Black Display
B11G4AA	HP Engage 6.9 inch White Display
1XD80AA# ABA, # ABT, # AC3	HP Engage One 10 Display
1XD81AA# ABA, # ABT, # AC3	HP Engage One 10t Display
3FH66AA#ABA,#ABT,#AC3	HP Engage One 10w Display
3FH67AA#ABA,#ABT,#AC3	HP Engage One 10tw Display
20C49A4#AB1,#AB2,#ABT,#AC3	HP Engage One 14 FHDMonitor
20C50A4#AB1,#AB2,#ABT,#AC3	HP Engage One 14 FHDNo Stand Monitor
20C51AA# AB1,# AB2,# ABT,# AC3	HP Engage One 14t FHDMonitor
20C52A4#AB1,#AB2,#ABT,#AC3	HP Engage One 14t FHDNo Stand Monitor
2D9\5A4#ABT,#AC3	HP Engage One 16t FHDMonitor
2D9X0A4#ABT,#AC3	HP Engage One 16t FHDNo Stand Monitor
2D9Y5A4#ABT,#AC3	HP Engage One 16ts FHDMonitor
2D9Z4AA#ABT, #AC3	HP Engage One 16ts FHDNo Stand Monitor

## HP Engage One Pro G2 Customer Facing Displays (CFDs) Stands

AMO Part No.

Description

10P60AA

HP Engage 6 Clean Mount Arm Bracket



## HP Engage One After Market Option Matrix

10P61AA	HP Engage 6 Stability Mount Arm Bracket
10P77AA	HP Engage 10 Clean Mount Stand
10P78AA	HP Engage 10 Stability Mount Stand
10P58AA	HP Engage 14 Clean Mount Stand
10P62AA	HP Engage 14 Stability Mount Stand

## HP Integrated Peripherals AMOs

AMO Part No.	Description
9YH50AA	HP Engage One Pro G2 Fingerprint Reader
2U551AA	HP Engage One Pro G2 Magnetic Stripe Reader
2V9G4AA	HP Engage One Pro G2 White Magnetic Stripe Reader
9YH49AA#AB4, #ABA, #ABB	HP Engage One Pro G2 Bar Code Scanner

## HP All-in-One Adjustable Height Stand

For Engage One Pro 23.8" All-in-One systems





HP Engage One After Market Option Matrix



#### Model

HP All-in-One Adjustable Height Stand Black HP All-in-One Adjustable Height Stand White 518U6AA 518U7AA

#### Introduction

Optimize viewing of the Engage One Pro 23.8" All-in-One system with the HP All-in-One Adjustable Height Stand. Available in either black or white, this stand allows for height adjustment, tilt, and pan.

## Key Features and Benefits

- Position All-in-One for maximum ergonomic comfort—promotes wellness in any work area
- Small footprint frees up your workspace and increases your efficiency
- Integrated base rollers enable 360° rotation of the stand so you can share your views with others
- Features technology that enables light touch adjustments without levers or knobs
- Five-inch (13 cm) height adjustment (landscape mode) ergonomically accommodates average range of users
- Easy to use—simple installation and effortless operation
- Everything is included to neatly route cables behind the stand, out of the way
- IEC 62368-1 certified

## Compatibility



#### HP Engage One After Market Option Matrix

The HP All-in-One Adjustable Height Stands are compatible with the Engage One Pro 23.8" All-in-One system, both in portrait and landscape orientation, when an Engage One Pro VESA Mount or VESA Hub is configured on the system.

**Requirements**: The Engage One Pro VESA Mount or the Engage One Pro VESA Hub is required to mount the HP Engage One Pro G2 23.8" system onto the HP All-in-One Adjustable Height Stand. SKU options are listed below and are sold separately from the stand.

Drop-in-box SKUs (for configuration with HP Engage One Pro G2 system)

#### For black systems:

- HP Engage One Pro G2 AiO Slim VESA Mount (A30MJAV)
- HP Engage One Pro G2 AiO VESA Hub (A30MMAV)

#### For white systems:

- HP Engage One Pro G2 AiO Slim VESA Mount White (A30MKAV)
- HP Engage One Pro G2 AiO VESA Hub White (A30MNAV)

#### After-market option SKUs

#### For black systems:

- HP Engage One Pro G2 AiO Slim VESA Mount (1A4E7AA)
- HP Engage One Pro G2 AiO VESA Hub (9YH42AA)

#### For white systems:

- HP Engage One Pro G2 AiO Slim VESA Mount White (326R7AA)
- HP Engage One Pro G2 AiO VESA Hub White (326R6AA)

#### Certifications:

- IEC 62368-1:2014
- UL 62368-1, 2<sup>nd</sup> Ed. And CAN/CSA C22.2 No. 62368-1-14, 2<sup>nd</sup> Ed.

#### Compliant with:

- EN 62368-1:2014/ A11:2017
- BS EN 62368-1:2014/ A11:2017

### Service and Support

Three (3) year limited warranty with advance exchange when purchased from HP.

#### General

Lift (Height Adjust) in 5" (13 cm)

Landscape Mode

Lift (Height Adjust) in Portrait 2.5" (6.4 cm)

Mode

**Weight Capacity** 16-36 lb (7.3-16.3 kg)

Monitor up/down tilt Up to +25°/-5° (depends on the height)

**Pan** 360°

#### Mechanical



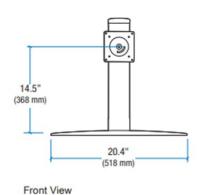
### HP Engage One After Market Option Matrix

Product Weight 13.8 lb (6.2 kg)

**Product Dimensions** 20.4" x 11.5" x 17.6" (51.8 cm x 29.2 cm x 44.8 cm)

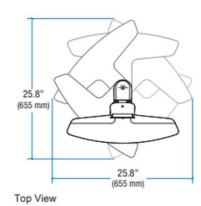
Shipping Weight 17.4 lb (7.9 kg)

**Shipping Dimensions** 23" x 13" x 7.3" (58.5 cm x 33.0 cm x 18.5 cm)





Side View



**Box Contents** 

Base, stand, monitor mounting bracket, screws, weight adjustment tool, cable ties, quick-setup manual

## HP Engage 6.9 inch Customer Facing Display



#### Model

HP Engage 6.9 inch Customer Facing Display

B11G3AA



# HP Engage One Pro G2 All-In-One system 15.6", 19.5" and 23.8" Models

# QuickSpecs

#### HP Engage One After Market Option Matrix

HP Engage 6.9 inch Customer Facing Display White

B11G4AA

#### Introduction

Give customers a clear view of their transactions and sharing engaging, colorful, dynamic content at the point of sale with LCD touch display.

## **Key Benefits**

- 6.9 inch diagonal compact LCD display that integrates easily into your retail solution.
- Position as need with adjustable height and swiveling of the display head.
- Place the durable, dust resistant display in a range of high traffic areas.
- A USB connector powers the display and eliminated the need for additional cabling.
- The edge to edge, bezel free 63 esign is easy to clean, helps protection from dust, and create a sleek, modern appearance.



# HP Engage One Pro G2 All-In-One system 15.6", 19.5" and 23.8" Models

# QuickSpecs

Overview - After Market Options

## Compatibility

The HP Engage 6.9 inch Customer Facing Display is compatible with HP Retail Point of Sale Systems.

Note: Not all Point of Sale system models are available in all regions.

### Service and Support

Three (3) year limited warranty with advance exchange when purchased from HP.



#### Overview - After Market Options

#### General

Display MethodBacklit LEDBrightness400 NitsResolution1440 x 720Pixel Pitch0.105 x 0.105 mmActive Area75.6 (H) x 151.2 (V) mm

Contrast Ratio 1000:1 (max)

**Response Rate** 25 ms (rise+fall time)

Viewing Angle Left: 85° Right: 85°

Top: 85° Bottom: 85°

Color Gamut 70% (CIE 1931 Standard NTSC)

Mechanical

**Display Dimensions** 

(WxHxD)

171.4 x 76.2 x 56.35 mm

Display Weight 0.25 kg

Hinge Adjustability Rotation Range 0°~90° (normal using)

Folded to 90° for shipping

Color HP Black / White

Connection

Interface USB

Power

Operating Voltage 5V

Full Load Current 6.5W (DC +5V, 1300mA)

Idle Current 0.64W TBD

Temperature Range

Operating 0°C to 35°C [32 to 95°F] at 10% to 90% humidity (non-condensing)

Non-operating -30°C to 65°C [-22 to 149°F] at 0% to 95% humidity (38.7°C maximum wet bulb

temperature)

Webcam 30fps USB 2.0 webcam, 5MP (2560x1920) resolution

Note: The Integrated webcam is a windows Hello Camera and IR is supported on 5MP

Camera

**Operating System** 

Compatible with: Windows 11 Pro 64-bit

Windows 10 Professional 64-bit)
Windows 10 IoT Enterprise 2021 LTSC
Windows 10 IoT Enterprise 2019 LTSC

Android<sup>™</sup> 11 Android<sup>™</sup> 11 AOSP Android<sup>™</sup> 11 GMS FreeDos 2.0

SUSE Linux® Enterprise Server 15

**Kit Contents** 

HP Engage 6.9 inch Customer Facing Display, documentation, warranty card.



Overview - After Market Options

## HP Engage One Pro G2 Integrated Barcode Scanner





#### Model

HP Engage One Pro G2 Integrated Barcode Scanner Configure to Order (CTO) with HP Engage HP Engage One Pro G2 Integrated Barcode Scanner After-market option (AMO) B3WY5AV (bottom), B3WY8AV (left), B3WZ0AV (right) B6BP1AA

#### Introduction

This integrated scanner streamlines your checkout area, while offering placement options, acceptance of various barcodes and coupons, and enhanced features for an easier, more accessible checkout experience.

## Key Features and Benefits

- Enjoy a configurable, clutter-free scanning space. Our new integrated barcode scanner inserts into the left, right, or bottom of the HP Engage One Pro G1 AiO or HP Engage One Pro G2 AiO for a sleek, seamless look.
- Quickly scan mobile wallets and digital coupons from customer mobile devices or printed 1D and 2D barcodes, or validate customer identity with passport OCR.
- Enable both employees and customers alike to scan items with ease. The unit reads barcodes when they're placed within 1.2" to 18.5" \*inches from the scanner.
- Minimize fatigue by adjusting the scan light for your ambient lighting conditions—lower the brightness in darker environments and increase in brighter environments.
- Choose to have the barcode scanner included when you purchase your HP Engage One Pro G2 AiO, or add it on later as you need the upgrade. \*\*
- The HP Engage One Pro G2 AiO flip- sensing feature will turn off the LED when the head unit is flipped.
- Enjoy support for your retail operating system of choice. The HP Engage One Pro G2 Integrated Barcode Scanner supports Windows 11, Windows 10, Windows IoT, Linux®, and Android-based systems.
- Rest easy that your IT investment is supported by a three-year standard limited warranty.

## Compatibility



<sup>\*</sup>Min/max reading distance vary for different symbologies/densities.

<sup>\*\*</sup>Optional feature sold separately or as an add-on feature.

#### Overview - After Market Options

The HP Engage One Pro G2 Integrated Scanner is compatible with the HP Engage One Pro All-in-One system and the HP Engage One Pro G2 All-in-One system.

Note: Not all Point of Sale systems are available in all regions.

### Service and Support

Three (3) year limited warranty with advance exchange when purchased from HP.

#### General

Image Sensor 1200 x 800 CMOS

Illumination Aimer White LED

Red LED 625±10nm

Depth of Field Typical Performance \*

 Symbologies
 Depth of Field

 EAN-13
 50mm-470mm (13mil)

 Code39
 55mm-260mm (5mil)

 PDF-417
 60mm-190mm (6.7mil)

 Data Matrix
 43mm-240mm (10mil)

 QR Code
 30mm-320mm (15mil)

Symbol Contrast 25% minimum reflectance

Roll (tilt)  $360^{\circ}$ Pitch  $\pm 60^{\circ}$ Skew  $\pm 60^{\circ}$ 

Field of View Horizontal 47°, Vertical 30°

**1D decode symbologies** Autodiscriminates all standard 1D codes including GS1 DataBar™ linear codes.

AIM 128

China Post 25 Codabar Code 11 Code 39 Code 49 Code 93 Code 128 Code 16K Coupon EAN-8 EAN-13 Febraban

GS1-128 (UCC/EAN-128)

GS1 Composite (EAN UCC Composite)

GS1 Databar (RSS) Industrial 25 Interleaved 2 of 5

ISBN ISBT 128 ISSN ITF-6 ITF-14 Matrix 25



#### Overview - After Market Options

MSI-Plessey Plessey Standard 25 UPC-A UPC-E

2D decode symbologies Aztec Code

Chinese Sensible Code

Code One Data Matrix GM Code MaxiCode MicroPDF417 Micro QR Code

PDF417 QR Code

Postal decode Australian Post

symbologies KIX Post

Royal Mail

USPS Intelligent Mail

USPS Planet USPS Postnet

OCR symbologies Passport OCR

Mechanical

**Dimensions (WxDxH)** 30.7 x 45.0 x 10.1 mm (Maximum)

Weight 9.6g Color Black

Interface/Connection

Interface USB

**Temperature** 

Operating -20°C to 40°C (-4°F to 104°F)

Storage -40°C to 70°F (-40°F to 158°F)

Humidity (non- 5% to 95%

condensing)

Power

Operating Voltage 5VDC±5%

Current at 5VDC Operating: 300mA (RMS typical), 450mA (RMS max.)

Idle: <50mA (level mode), <135mA (sense mode)

Sleep: <1.5mA

Rated Power Consumption 1.5 W Typical

**Drivers** Windows USB HID-KB and OPOS & JPOS (via USB-COM mode drivers)

Ambient Light 0- 100,000 lux

Water Penetration Protection IP44

**Operating System** 

Compatible with: Windows
Windows 11

Windows 10 Pro 64bit

Windows 10 IoT Enterprise 2016 LTSB 64bit (RS1) Windows 10 IoT Enterprise 2019 LTSC 64bit (RS5)



### Overview - After Market Options

#### Linux

Red Hat/CentOS 5.6.8 and above (64 bit) Suse Linux Enterprise 11/12 SP3 and above (64 bit) Ubuntu 12.04/14.04 LTS and above (64 bit)

#### **Android**

Android 8.0 and above

#### **Agency Certifications**

FCC Part15, Class B, CE EMC Class B, IEC62471, RoHS, IEC 62368-1, AfPS GS 2019, EK1-ITB 2000, UL, CNS13438

#### **AMO Kit Contents**

HP Engage One Pro G2 Integrated Barcode Scanner, documentation, warranty card



Overview - After Market Options

## HP Engage One Magnetic Stripe Reader





#### Model

HP Engage One Pro G2 Magnetic Stripe Reader HP Engage One Pro G2 White Magnetic Stripe Reader 2U551AA 2V9G4AA

## Compatibility

The HP Engage One Pro G2 Magnetic Stripe Reader is compatible with the HP Engage One Pro G2 All-in-One System.

**NOTE:** Not all Point of Sale system models are available in all regions.

### Service and Support

Three (3) year limited warranty with advance exchange when purchased from HP.



### Overview - After Market Options

#### **General**

Magnetic stripe formats ISO 7811, AAMVA

**Card Thickness** 0.38 to 1.14 mm (0.015 to 0.045 in)

**Indicators** Bi-colored LED, beeper (requires system audio driver)

**Card Speed** 3 to 75 ips (7.6 to 190.5 cm/s)

Mechanical

Weight  $5.67 \, \mathrm{g}$ 

Slot width 1.14 mm (0.045 in)

Color **HP Black HP White** 

Connection

Interface Eight-pin male Molex 51021-0800

0.03 mA

Cable Length 125 ± 6.4 mm

**Power** 

**Power Supply** 3.0 to 3.6 VDC I/O Voltage Range 2.7 to 3.6 VDC

**Active Power Supply** 

Current

mA Standby Power

**Supply Current** 

**Temperature Range** 

Operating 0°C to 55°C

**Relative Humidity** -10% to 90% non-condensing

Reliability

**Operating Life** 1,000,000 card swipes minimum

**Agency Certifications** 

FCC, CE, USB-IF

**Operating Systems** 

Compatible with: Windows 11 Pro 64-bit

> Windows 10 Professional (64-bit) Windows 10 IoT Enterprise 2021 LTSC Windows 10 IoT Enterprise 2019 LTSC

Android™ 11 Android™ 11 AOSP Android™ 11 GMS FreeDOS 2.0

SUSE Linux® Enterprise Server 15

Kit Contents

HP Engage One Pro G2 Magnetic Stripe Reader, documentation, warranty card.



Overview - After Market Options

## HP Engage One Pro G2 Fingerprint Reader



#### Model

HP Engage One Pro G2 Fingerprint Reader

9YH50AA

## Compatibility

The HP Engage One Pro G2 Fingerprint Reader is compatible with the HP Engage One Pro G2 All-in-One System.

## Service and Support

Three (3) year limited warranty with advance exchange when purchased from HP.



#### Overview - After Market Options

#### General

Sensor Type Capacitive
Array Size 208 x 288 pixels

Image Resolution 508 DPI

Gray Scale 8-bit (256 levels)

Mechanical

Image Area10.4 x 14.4 mmImage/CoatingSteel CoatColorHP Black

**Digital ID Reliability** 

NVM Storage 100 templates
Data Retention 20 years

Erase/Write 100,000 cycles

Interface/Connection

Interface USB 2.0

Interface Connector 5 pin, 0.8mm pitch wire-type (gold-plated)

**Temperature** 

 Operating
 -30° to +85°C

 Storage
 -40° to +85°C

 Humidity (non 5% to 85%

condensing)

ESD Tolerance IEC 61000-4-2 Level 4

**Power** 

**Consumption** Supply voltage: single supply voltage, 3.0V to 3.6V

Imaging mode: 105 mA @ 3.3V Sleep mode: 1350 uA @ 3.3V

Wake-up Time <15 ms (Sleep to imaging)

**Drivers** 

Windows USB HID-KB and OPOS & JPOS (via USB-COM mode drivers)

**Operating Systems** 

Compatible with: Windows 11 Pro 64-bit

Windows 10 Professional (64-bit) Windows 10 IoT Enterprise 2021 LTSC Windows 10 IoT Enterprise 2019 LTSC

Android™ 11 Android™ 11 AOSP Android™ 11 GMS FreeDOS 2.0

SUSE Linux® Enterprise Server 15

**Agency Certifications** 

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

**Kit Contents** 

HP Engage One Pro G2 Fingerprint Reader, documentation, warranty card.



#### Overview - After Market Options

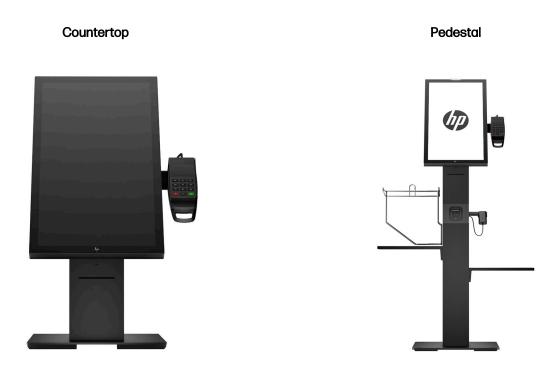
### Service and Support

Ninety-day (90-90-90), one-year (1-1-1), and three-year (3-3-3) limited warranty delivers (ninety days/one year/three years) of on-site, next business day<sup>2</sup> service for parts and labor and complimentary limited technical support.<sup>3</sup> Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing an optional HP Care Pack.<sup>1</sup> To choose the right level of service for your HP product, visit HP Care Pack Central: http://www.hp.com/go/cpc

#### **NOTES:**

- 1. Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.
- 2. On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
- 3. Technical support applies only to HP-configured Compaq and third-party HP-qualified hardware and software. 24 x 7 support may not be available in some countries.

### **HP Engage Express**





### **HP Engage Express Countertop**



- 1. Indicator Light
- 2. HP Engage One Pro AiO Head Unit
- 3. Printer Drawer Pin Hole<sup>1</sup>
- 4. Custom Modus 3 Printer<sup>2</sup>

- 5. Front Payment Connector
- 6. HP Engage Express Countertop Barcode Scanner Cradle
- 7. HP Engage 2D G2 Barcode Scanner

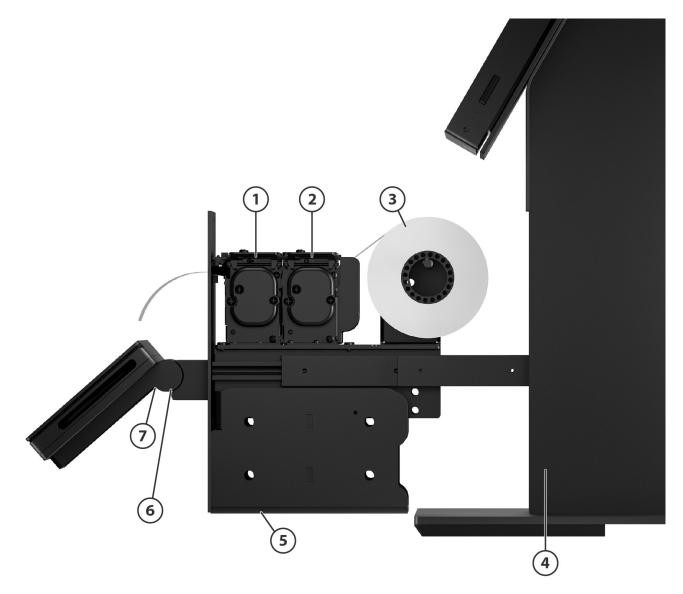
Note: Shown is HP Engage Express Countertop 4 (6P2E5AA), HP Engage Express Countertop Barcode Scanner Cradle (includes HP Engage 2D G2 Barcode Scanner) (6P2F9AA).

<sup>1</sup>Metal pin comes with HP Engage Countertop in Printer configuration only and the metal pin is used to open printer drawer. <sup>2</sup> Printer is factory installation only and must be configured at purchase.

The optional HP Engage Express Universal Payment Arm is available for generic payment terminals on this kiosk. It requires a Havis payment backplate, sold separately, to connect to a payment terminal. Payment terminal not included. Must choose an HP Engage Express Countertop or Pedestal Stand enabled for front payment at purchase or the HP Engage Express Universal Payment Arm will not connect to the stand. Please contact your Sales representative for more details.



#### **Custom Modus 3 Printer**



- 1. Printer Presenter<sup>1</sup>
- 2. Custom Modus 3 Printer<sup>2</sup>
- 3. Receipt Paper
- 4. HP Engage Express Countertop

- 5. Front Printer Drawer<sup>2</sup>
- 6. Payment Connector4
- 7. 75mm VESA

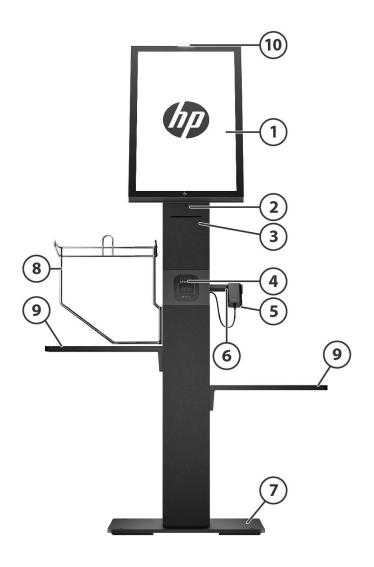
<sup>1</sup>Helps to prevent jamming of printer receipt paper.

<sup>2</sup>Custom Modus 3 Printer is factory installed only and must be configured at purchase.

The optional HP Engage Express Universal Payment Arm is available for generic payment terminals. It requires a Havis payment backplate, sold separately, to connect to a payment terminal. Payment terminal not included. Must choose an HP Engage Express Countertop or Pedestal Stand enabled for front payment at purchase or the HP Engage Express Universal Payment Arm will not connect to the stand. Please contact your Sales representative for more details.



## **HP Engage Express Pedestal**



- 1. HP Engage One Pro AiO Head Unit
- 2. Printer Drawer Pin Hole<sup>1</sup>
- 3. Custom Modus 3 Printer<sup>2</sup>
- 4. Datalogic Magellan 1500i Presentation Scanner<sup>4</sup>
- 5. HP Engage 2D G2 Barcode Scanner
- 6. HP Engage Express Pedestal Barcode Scanner Cradle
- HP Engage Express Pedestal Base Plate holes for mounting x4<sup>3</sup>
- 8. HP Engage Express Bag Holder
- 9. HP Engage Express Shelves
- 10. Indicator light

<sup>1</sup>Metal pin comes with HP Engage Express Printer configurations only and is used to open printer drawer.



# HP Engage One Pro G2 All-In-One system 15.6", 19.5" and 23.8" Models

## QuickSpecs

### Overview - After Market Options



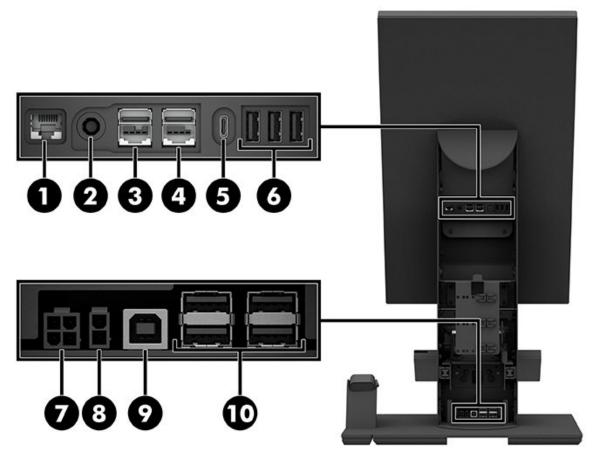
<sup>&</sup>lt;sup>2</sup>Custom Modus3 Printer is factory installed only and must be configured at purchase.

<sup>&</sup>lt;sup>3</sup>HP Engage Express Pedestal Stand must be bolted to the floor, mounting bolts are not included.

<sup>&</sup>lt;sup>4</sup>The Datalogic Magellan 1500i Presentation Scanner is factory-installed only and must be configured at purchase.

### **Rear View**

HP Engage Express VESA® hub			
1.	1x RJ-45 Port	4.	1x Powered USB
			12V Port
2.	1x DC Power	5.	1x USB-C
	Connector		
3.	1x Powered USB 24V	6.	3x USB-A 3.2
	Port		



	HP Engage Mini Hub			
7.	1x 4-Pin Power	9.	1x USB-B (USB-A	
	Connector (Power		extension from	
	source for Pro		VESA® Hub)	
	VESA® hub)			
8.	1x 2-Pin Power	10.	4x USB-A 2.0	
	Connector (Power			
	source for Printer)			

**Note:** HP Engage One Pro VESA® hub can be configured with HP Engage One Pro AiO for compatibility with all HP Engage Express Countertop or Pedestal Stands.



HP Engage One Pro Hubless VESA for the HP Engage One Pro AiO is ONLY compatible with HP Engage Express Countertop or Pedestal Stands without a printer (Countertop SKUs 1 & 2; Pedestal SKUs 5 & 6).

HP Engage Mini Hub is included in HP Engage Express Countertop and Pedestal Stands.

**Note:** If a USB peripheral needs more than 5V of power, use the 12V or 24V Powered USB ports in the Pro VESA Hub rather than the USB-A ports in the Mini Hub. Power voltage threshold may vary depending on the peripheral.

### HP Engage Express Countertop Barcode Scanner Cradle



- The HP Engage Express Countertop Barcode Scanner Cradle includes the HP Engage 2D G2 Barcode Scanner.
- The HP Engage Express Countertop Barcode Scanner Cradle is purchased separately from HP Engage Express Countertop Stands.
- It can be installed on the right or left side of the countertop stand.



**Note:** HP Engage Express Countertop Barcode Scanner Cradle is only compatible with HP Engage Express Countertop Stands.

## **HP Engage Express Countertop Mount**



- The HP Engage Express Countertop Mount is sold separately.
- The 4 screws to connect the countertop mount to a surface are not included.

Note: HP Engage Express Countertop Mount is only compatible with HP Engage Express Countertop Stands.

## **HP Engage Express Universal Payment Arm**





#### Overview - After Market Options

- The HP Engage Express Universal Payment Arm (7Y397AA) is optional and sold separately. It is only
  compatible with HP Engage Express Countertop SKUs 2 and 4 and HP Engage Express Pedestal SKUs 6, 8,
  and 9.
- To secure the payment terminal to the third-party payment backplate and the Universal Payment Arm, a key mechanism is included with the HP Engage Express Universal Payment Arm for extra security.
- Dimensions: 7.61" (L) x 3.50" (W) x 2.39" (H)/ 19.3 cm (L) x 8.9 cm (W) x 6.1 cm (H)

Note: The HP Engage Express Universal Payment Arm is available for generic payment terminals on select kiosk SKUs. It requires a Havis payment backplate, sold separately, to connect to a payment terminal. Payment terminal not included. Must choose an HP Engage Express Countertop or Pedestal Stand enabled for front payment at purchase or the HP Engage Express Universal Payment Arm will not connect to the stand.

### **HP Engage Express Side Payment Arm**

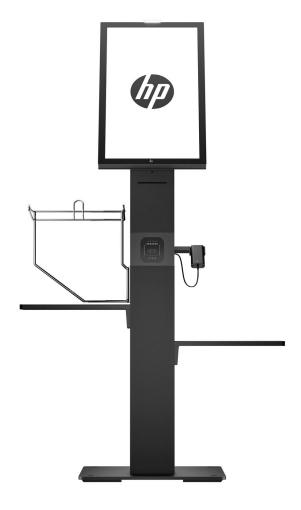


- The HP Engage Express Side Payment Arm (9Y3Q8AA) is optional and sold separately. It is only compatible with HP Engage Express Countertop SKUs 1 and 3 and HP Engage Express Pedestal SKUs 5, 7, 10, 11, and 12.
- Side Payment Arm Dimensions: 12.7" (L) x 8.5" (W) x 3.7" (H)/ 32.3 cm (L) x 21.6 cm (W) x 9.3 cm (H)
- The shipping weight is 3.5 lb
- Compatibility limitations:
  - o Not compatible with 23.8" landscape.
  - o Not compatible with 19.5" landscape with a payment terminal width that is greater than 3.3 in/85 mm.

Note: The HP Engage Express Side Payment Arm is available for generic payment terminals on select kiosk SKUs. It requires a Havis payment backplate, sold separately, to connect to a payment terminal. Payment terminal not included. Must choose an HP Engage Express Countertop or Pedestal Stand enabled for side payment at purchase or the HP Engage Express Side Payment Arm will not connect to the stand.

## HP Engage Express Shelves & HP Engage Express Bag Holder





- The HP Engage Express Shelves and HP Engage Express Bag Holder are sold separately.
- HP Engage Express Bag Holder is left-sided. If a bag holder is used, a shelf must be purchased and placed underneath the bag holder to hold the weight of items placed in the bags. Shelves are not interchangeable and can be adjusted up or down on the pedestal stand. Maximum weight per shelf is 20 kg/44lb.

Note: HP Engage Express Shelves and bag holder are only compatible with HP Engage Express Pedestal Stands.



Overview - After Market Options

## HP Engage One Express AMO (Configurations)

AMO Number	AMO Name	AMO Description
6P2E2AA	HP Engage Express Countertop 1	Deliver maximum functionality in a small footprint design with the HP Engage Express Countertop Stand. This simple stand meets your essential self-service needs without additional peripherals. Compatible with side payment arm.
6P2E3AA	HP Engage Express Countertop 2	Deliver maximum functionality in a small footprint, self-service design with the HP Engage Express Countertop Stand with included front payment connector. Sleek and streamlined, it is a versatile option that accommodates your choice of payment. <sup>1</sup>
6P2E4AA	HP Engage Express Countertop 3	Deliver maximum functionality in a small footprint, self-service design with the HP Engage Express Countertop Stand with included Custom Modus 3 Printer. The printer sleekly integrates into a front accessible drawer for easy maintenance. Compatible with side payment arm.
6P2E5AA	HP Engage Express Countertop 4	Deliver maximum functionality in a small footprint, self-service design with the HP Engage Express Countertop Stand with included front payment connector¹ and Custom Modus3 Printer.² The payment arm accommodates a variety of payment options, and the printer sleekly integrates into a front accessible drawer for easy maintenance.
6P2E7AA	HP Engage Express Pedestal 5	Enhance and streamline customer experiences with an elegantly crafted, highly versatile self-service stand. The HP Engage Express Pedestal Stand <sup>3</sup> delivers a sleek footprint and is ruggedly durable — meeting all your essential self-service needs. Compatible with side payment arm.
6P2E8AA	HP Engage Express Pedestal 6	Enhance and streamline customer experiences with the sleek HP Engage Express Pedestal Stand <sup>3</sup> with included front payment connector. It is elegantly crafted, ruggedly durable, and the payment arm accommodates a variety of payment options. <sup>1</sup>
6P2E9AA	HP Engage Express Pedestal 7	Enhance and streamline customer experiences with the sleek HP Engage Express Pedestal Stand <sup>3</sup> with included Custom Modus3 Printer <sup>2</sup> . It is elegantly crafted, ruggedly durable, and the printer cleanly integrates into a front accessible drawer for easy maintenance. Compatible with side payment arm.
6P2F0AA	HP Engage Express Pedestal 8	Enhance and streamline customer experiences with the elegantly crafted, ruggedly durable HP Engage Express Pedestal Stand <sup>3</sup> with included front payment connector <sup>1</sup> and Custom Modus3 Printer <sup>2</sup> . The payment arm accommodates a variety of payment options, and the printer sleekly integrates into a front accessible drawer for easy maintenance.
6P2F1AA	HP Engage Express Pedestal 9	Enhance and streamline customer experiences with the elegantly crafted, ruggedly durable HP Engage Express Pedestal Stand³ with included front payment connector¹, Custom Modus3 Printer², and hand-held HP Engage 2D G2 Barcode Scanner. The payment arm accommodates a variety of payment options, the printer sleekly integrates into a front accessible drawer for easy maintenance, and the hand-held barcode scanner allows scanning of 1D and 2D omnidirectional barcodes as well as mobile device scanning.
6P2F2AA	HP Engage Express Pedestal 10	Enhance and streamline customer experiences with the elegantly crafted, ruggedly durable HP Engage Express Pedestal Stand³, Custom Modus3 Printer², and Datalogic Magellan 1500i Presentation Scanner⁴. The payment arm accommodates a variety of payment options, and the printer sleekly integrates into a front accessible drawer for easy maintenance. The barcode scanner integrates into the stand for a seamless scanning solution. Compatible with side payment arm.
6P2F3AA	HP Engage Express Pedestal 11	Enhance and streamline customer experiences with the elegantly crafted, ruggedly durable HP Engage Express Pedestal Stand³, Custom Modus3 Printer², integrated Datalogic Magellan 1500i Presentation Scanner⁴, and hand-held HP Engage 2D G2 Barcode Scanner. It delivers maximum function in a modern, small footprint design to complement your environment. Compatible with side payment arm.
9Y3Q7AA	HP Engage Express Pedestal 12	Enhance and streamline customer experiences with the elegantly crafted, ruggedly durable HP Engage Express Pedestal Stand³ with Custom Modus3 Printer² and hand-



HP Engage One Pro G2 All-In-One system 15.6", 19.5" and 23.8" Models

Overview - After Market Options	
	held HP Engage 2D G2 Barcode Scanner. The printer sleekly integrates into a front accessible drawer for easy maintenance and the hand-held barcode scanner allows scanning of 1D and 2D omnidirectional barcodes as well as mobile device scanning. Compatible with side payment arm.



## HP Engage Express AMO (Add-Ons)

AMO Number	AMO Name	AMO
		Description
6P2F9AA	HP Engage Express Countertop BCS Cradle	Built for
		demanding
		environments,
		the HP
		Engage
		Express
		Countertop
		Barcode
		Scanner
		Cradle⁵
		provides an
		optimal place
		for your hand-
		held barcode
		scanner to
		rest while
		keeping
		counters
		clutter-free.
6P2G0AA	HP Engage Express Shelves	Add greater
		convenience
		to the self-
		checkout
		experience
		with HP
		Engage
		Express
		Shelves <sup>6</sup> for
		the HP
		Engage
		Express
		Pedestal
		Stand. <sup>3</sup> One
		right shelf
		and one left
		shelf are
		included.
6P2F7AA	HP Engage Express Bag Holder	Easy to use, the
		HP Engage
		Express Bag
		Holder <sup>6</sup>
		securely holds
		bags on the left side of the HP
		Side of the HP



#### Overview - After Market Options

		<del></del>
		Engage
		Express
		Pedestal
		Stand <sup>3</sup> for
		quick and
		efficient
		checkout.
7P9E2AA	HP Engage Express Countertop Mount	Mount the HP
		Engage
		Express
		Countertop
		Stand to the
		counter for
		extra security.
7Y397AA	HP Engage Express Universal Payment Arm	Universal
		Payment arm <sup>7</sup>
		that enables a
		variety of
		payment
		terminals to
		connect to the
		front of HP
		Engage
		Express
		Countertop
		and Pedestal
		Stands.
9Y3Q8AA	HP Engage Express Side Payment Arm	Side Payment
		arm <sup>9</sup> that
		enables a
		variety of
		payment
		terminals to
		connect to
		the side of the
		screen of the
		HP Engage
		Express
		Countertop
		and Pedestal
		Stands.

#### Disclaimers:

- 1. The Custom Modus 3 Printer is factory install only and must be configured at purchase.
- 2. HP Engage Express Pedestal Stand must be bolted to the floor, bolts not included.
- 3. The Datalogic Magellan 1500i Presentation Scanner is factory install only and must be configured at purchase.
- 4. HP Engage Express Countertop Cradle includes the HP Engage 2D G2 Barcode Scanner and is only compatible with the HP Engage Express Countertop Stand.
- 5. HP Engage Express Shelves and HP Engage Express Bag Holder are only compatible with the HP Engage Express Pedestal Stand. Maximum weight per shelf is 20 kgs/44lbs.



# HP Engage One Pro G2 All-In-One system 15.6", 19.5" and 23.8" Models

## QuickSpecs

### Overview - After Market Options

- 6. HP Engage Express Universal Payment Arm requires a payment backplate to connect to a payment terminal. Payment backplate and payment terminal are not included. Must choose an HP Engage Express Countertop or Pedestal Stand enabled for payment at purchase or the Universal Payment Arm will not connect to the stand.
- 7. HP Engage Express Side Payment Arm requires a payment backplate to connect to a payment terminal. Payment backplate and payment terminal are not included. Must choose an HP Engage Express Countertop or Pedestal Stand enabled for side payment at purchase or the side payment arm will not connect to the stand.



## Overview - After Market Options

## **PORTS**

#### HP Engage One Pro Pro VESA® Hub I/O:

- 1x 140W data port (PDO cable to Head Unit)<sup>1</sup>
- 1x RJ45 vPro NIC
- 1x UAJ (Audio jack)
- 4x Integrated USB-A Gen1 Peripherals ports
- 2x USB3.2 G1 Type-A / 900mA
- 2x USB3.2 G1 Type-A / 2.2A

### HP Engage Express Mini hub I/O:

- 1x 4 Pin Power Connector (Power source for Pro VESA® hub)
- 1x 2 Pin Power Connector (Power source for Printer)
- 1x USB-B (USB-A extension from VESA® Hub)
- 4x USB-A 2.0

Note: HP Engage Mini Hub is included in HP Engage Express Countertop and Pedestal Stands. Pro VESA® Hub must be configured on the HP Engage One Pro to work with HP Engage Express Stands.

Note: If a USB peripheral needs more than 5V of power, use the 12V or 24V Powered USB ports in the Pro VESA Hub rather than the USB-A ports in the Mini Hub. Power voltage threshold may vary depending on the peripheral.

## **USB SPECIFICATION**

SpeedTerminologyHi-Speed USB 480Mbps signaling rateUSB 2.0SuperSpeed USB 5Gbps signaling rateUSB 3.2 Gen 1

## Integrated Custom Modus 3 Printer

#### General

### Supported Character Set/Resident Code Pages:

290 Japanese/ Katakana

437 US

720 Arabic

737 Greek

850 Multi-lingual

852 Slavic

855 Cyrillic

857 Turkish

858 with Eurosymbol

860 Portuguese

862 Hebrew

863 French Canadian

864 Arabic

865 Nordic

866 Cyrillic

932 Japanese

949 Korean - Hangul

1125 Ukrainian



## Overview - After Market Options

1250 Latin 1251 Cyrillic

1252 Windows Latin I

1253 Greek 1254 Turkish 1255 Hebrew 1256 Arabic 1257 Baltic 1258 Vietnamese

GB18030 Chinese (Simplified & Traditional)

ISO8859-2 Latin 2

KU42 Thai

Unicode support for resident fonts/ Code Pages

Bar Codes 1D: UPC-A, UPC-E, EAN 8, EAN 13, EAN 128, Code 39, Code 93, Code 128 Parsed, Codabar,

ITF

2D: QR Code, DataMatrix, PDF417

Print Method Direct Thermal
Printing Speed Up to 120 mm/sec

Printer Sensor Head temperature, paper presence, black mark, cover open, low paper

Resolution 203 DPI Roll Width 80 mm Print Width 76 mm Flash Memory 2 MB RAM 640 KB

Knife Full cut only (remove partial cut because HP Engage Express without presenter module

is not available)

Receipt-Columns 44/56 (80mm paper roll)

Paper Type Thermal Paper

Roll Core Diameter 25 mm

Paper size Page Mode: Fixed paper size (3", 8", 16", 22", 36", or 157")

Non-page Mode: Paper cut occurs at the end of the document

Estimated life 1,000,000 cuts

External roll diameter 80mm max.

Cash drawer Not supported

Knife cuts 1,000,000 cuts

**Print head life** 150 km or 100 M pulse durability

Interface USB2.0 type-A

Operating voltage 19.5V
Current consumption 0.8A
Standby consumption 0.03A

**Environmental Conditions** 

Operating temperature -20°C to 70°C



## Overview - After Market Options

Relative humidity

10% to 85% (w/o condensation)

Storage temperature

-20°C to 70°C

Storage relative

humidity

10% to 90% (w/o condensation)

**Drivers** 

Windows, OPOS, JPOS, Android, Linux

**Operating System** 

Compatible with:

Windows

• Windows 11 Pro 64-bit

• Windows 10 Pro 64-bit

Windows 10 IoT Enterprise 2019 LTSC 64-bit (RS5-based)

Windows 10 IoT Enterprise 2016 LTSB 64-bit (RS1-based)

Linux

CentOS: 8.4.2105-x86 64

• Fedora: Workstation-Live-x86\_64-34-1.2

OpenSUSE: Leap-15.3-DVD-x86 64

SUSE Linux: 12-SP5-Server-DVD-x86\_64-GM-DVD1, SUSE Linux-15-SP2-Full-x86\_64,

SUSE Linux 15-SP3-Full-x86\_64

• Ubuntu: 18.04.5-desktop-amd64, ubuntu-20.04.2.0-desktop-amd64, ubuntu-mate-20.04.2.0-desktop-amd64

Android

HP Android 11.0 (HP Engage One Pro AiO)



Overview - After Market Options

## HP Engage 2D G2 Barcode Scanner



## Model

HP Engage 2D G2 Barcode Scanner (Black)

### Introduction

Deliver an efficient customer experience with the reliable, versatile, and efficient HP Engage 2D G2 Barcode Scanner, HP's smallest, slimmest barcode scanner. It reads mobile wallets, digital coupons, and printed barcodes, and can be used by hand or in presentation mode.

## Key Features and Benefits

- Quickly scan mobile wallets and digital coupons from customer mobile devices or printed 1D and 2D barcodes. Intuitive feedback confirms a successful read.
- Supports a wide variety of symbols, including 1D, 2D, and OCR.
- Built into an IP42-sealed and drop-resistant (1.2 m/ 3.94 ft) housing, can stand up to tough environments.
- User-friendly illumination and aiming: Employs highly-visible laser aimer to achieve crisp and accurate targeting
  while using flicker-free white soft illumination to reduce eye strain and fatigue from long-time operation.
- Powerful data formatting capability: Allows customizing scanned data with ease and provides supporting software to address diverse application needs.

## Compatibility

The HP Engage 2D G2 Barcode Scanner is compatible with HP Retail & Industry Solutions systems. **NOTE:** Not all Point of Sale system models are available in all regions.

## Service and Support

Three (3) year limited warranty with advance exchange when purchased from HP. Additional HP Care Pack Services options are available to extend warranty coverage.



## Overview - After Market Options

#### General

Global Shutter **Scanner Technology Image Sensor** 1280 x 800 CMOS

Light source/illumination White LED

650 nm red laser diode **Aiming Read Rate** 60 frames/second **Motion Tolerance** 20 cm/second Resolution >= 3 mil\*

Field of View Horizontal: 47°; vertical: 30°

Typical Depth of Field Depth of Field distance determined by symbol length and scan angle. Printing

resolution, contrast, and ambient light dependent.

\*Test conditions: T=23°C; Illumination=3001ux using incandescent lamp; sample barcodes made by Newland.

Donath of Field

#### Typical Performance\*

N. I. annua v. v. VA /: altila

Narrow Wiath	Depth of Field
Code 39	55 mm - 220 mm (5 mil)
Data Matrix	45 mm - 245 mm (10 mil)
EAN-13	45 mm - 450 mm (13 mil)
PDF417	55 mm - 195 mm (6.7 mm)
QR Code	20 mm - 320 mm (15 mil)

<sup>\*</sup> Performance may be impacted by bar code quality and environmental conditions.

Min. Symbol Contrast

20% minimum reflectance difference\*

\*Test conditions: T=23°C; illumination=3001ux using incandescent lamp; sample

barcodes made by Newland.

Scan Angle\*

Roll (tilt) ±360°

> \*Test conditions: Scan Distance= (min. DOF + max. DOF)/2; T=23°C; Illumination=3001ux using incandescent lamp; 2D: QR Code; 10 Bytes;

Resolution=ISmil; PCS=0.8.

**Pitch** ± 55° ±60° Skew

**Additional Features** Data parsing (driver license parsing), data formatter

**Symbologies** 

1D (Linear) **AIM 128** 

> Codabar Code 11 Code 39 Code 49 Code 93



## Overview - After Market Options

Code 128 Code 16K Coupon EAN-8 EAN-13 Febraban

GS1-128 (UCC/ EAN-128)

GS1 Composite (EAN UCC Composite)

GS1 Databar (RSS) Industrial 25 Interleaved 2 of 5

ISBN
ISBT 128
ISSN
ITF-6
ITF-14
Matrix 25
MSI-Plessey
Plessey
Standard 25
UPC-A
UPC-E

2D Aztec Barcode

Chinese Sensible Code

Code One Data Matrix GM Code MaxiCode MicroPDF417 Micro QR Code PDF417

PDF417 QR Code

Postal Codes Australian Post

China Post 25

KIX Post (Netherlands) Royal Mail (UK) USPS Intelligent Mail

**USPS** Postnet

Mechanical/Electrical

**Dimensions (H x W x D)** 160 x 44 x 33 mm (6.30 x 1.73 x 1.18 in)

Cable length 1.8m (5.9 ft)

Color Ebony Black or Ceramic White

 Power Typical Current
 5V - 255.76 mA

 Weight
 130g (4.59 oz)

Interface USB

Input Voltage 5.0 Vdc +/- 5%
Typical Current 5V - 255.76 mA



## Overview - After Market Options

#### **Environmental**

Operating Temperature -20°C to 60°C (-4°F to 140°F)

Storage Temperature -40°C to 70°C (-40°F to 158 °F)

**Humidity** 5% to 95% relative humidity, non-condensing **ESD** ±15KV (air discharge); ±8KV (contact discharge)

**Drop** 1.2m (3.94 ft)

Sealing IP42

#### **Drivers**

Windows USB COM, OPOS, and JPOS

## **Operating System**

Compatible with: Windows

Win 11 Pro 64-bit Win 10 Pro 64-bit

Windows 10 IoT Enterprise LTSC 2021 64-bit Windows 10 IoT Enterprise LTSC 2019 64-bit Windows 10 IoT Enterprise LTSB 2016 64-bit

### Linux

Ubuntu 20.04.1 LTS

Ubuntu-18.04.6-desktop-amd64 Ubuntu-20.04.4.0-desktop-amd64 Ubuntu-22.04.0.0-desktop-amd64

RHEL 9.0-x86 64

SLE-12-SP5-Server-x86\_64 SLE-15-SP3-x86\_64 Debian-11.3.0-amd64

### **Agency Certifications**

FCC Part 15 Class B, CE EMC Class B, KCC, VCCI

#### **Option Kit Contents**

HP Engage 2D G2 Barcode Scanner with attached 5.9 ft (1.8M) USB cable, scanner stand



## Overview - After Market Options

## **HP Engage Indicator Light**



#### General

Standard Colors white, red, green, yellow

**Brightness** 6,400 nits in solid states; up to 10,000 nits in flicker states

56 (W) x 29.4 (H) x 8.3 (D) mm (2.2 x 1.6 x 0.3 inches)

56 (W) x 29.4 (H) x 53.5 (D) mm (2.2 x 1.6 x 2.1 inches)

Indicator Light Dimensions (excluding USB connector)

Indicator Light Module
Dimensions (including USB

Dimensions (including o

connector)

Net Weight Approx. 21 grams (0.74 oz)

 Interface
 USB in 5V only

 MTBF
 30,000 hours

 Power Consumption
 5V - 600mA

**EMC / Safety Standards** FCC, CE, VCCI, RCM, KCC, ICE, CSA, EAC

Power

Voltage (typical) 5 VDC +/- 10%

Current Consumption (typical) 200mA

Communication Interface USB (HID class)

**Operating System** 

Compatible with: Windows

Windows 10 IoT Enterprise 2019 LTSC 64-bit Windows 10 IoT Enterprise 2021 LTSC 64-bit Windows 10 Pro 21H2 64-bit and newer Windows 11 Pro 22H2 64-bit and newer



## Overview - After Market Options

#### Linux

Red Hat Enterprise Linux (RHEL) x64 8.5 and newer SUSE Linux Enterprise Server (SLES) x64 15 SP3 and newer Ubuntu x64 20.04.3.0 and newer

#### Android

Android 11 including Android 11 GMS

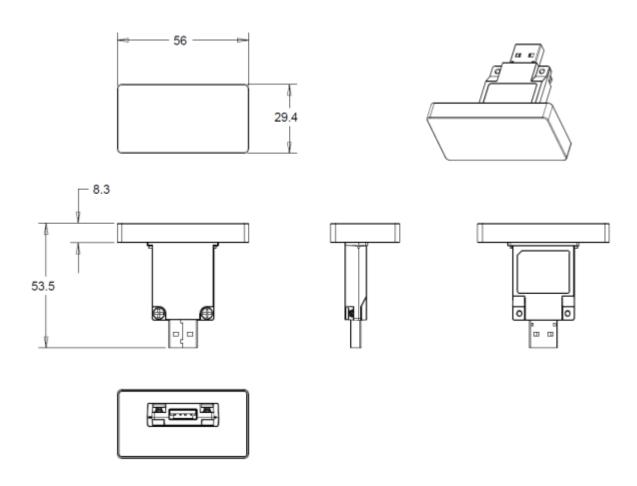
### Software Interface

**Default Settings** 

OPOS (Windows), JPOS (Linux, Windows, and Android) and HP Retail SDK for Android

- Initial state on Power on (plug-in): White
- Default setting of brightness: 50%

Note: HP Engage Indicator Light is an optional peripheral that requires factory installation and must be configured at HP Engage One Pro AiO purchase.



Dimensions in mm



Overview - After Market Options

## Datalogic Magellan 1500i Presentation Barcode Scanner



## **Key Features and Benefits**

- Seamlessly reads 1D and 2D bar codes, whether printed or displayed on mobile phone, laptop, or tablets.
- Digimarc® Barcode decoding.
- Subtle, adaptive illumination for user comfort.
- Compact, ergonomic design is ideal for hands-free or hand held operations
- Datalogic's 'Green Spot' technology for good-read feedback

#### General

Scanner Type Omnidirectional Imager
Source 1 Megapixel: 1280 x 800 pixel

**Light source** LED

**Depth of Field** Typical Performance\*

Narrow WidthDepth of Field1D/Linear Codes5 mils: 2.5 to 9.0 cm (0.9 to

3.5 in)

7.5 mils: 0 to 17.0 cm (0 to 6.6 in) 10 mils: 0 to 21 cm (0 to 8.2 in) UPC: 13 mils: 0 to 25.0 cm (0 to 9.8 in) 20 mils: 1.0 to 30.0 cm (0.4 to 11.8 in)

2D Codes PDF: 6.5 mils: 2.5 to 11.0 cm

(0.9 to 4.3 in)

Data Matrix: 13 mils: 0 to 17.0 cm (0 to 6.7 in)

PDF: 16 mils: 0 to 2.0 cm (0 to 7.8 in)

Data Matrix: 24 mils: 0 to 25.0 cm (0 to 9.8 in)

Symbol Contrast 25% minimum reflectance



## Overview - After Market Options

Roll (tilt)  $360^{\circ}$ Pitch  $\pm 65^{\circ}$ Skew  $\pm 75^{\circ}$ 

**1D decode symbologies** Autodiscriminates all standard 1D codes including GS1 DataBar™ linear codes.

2D decode symbologies Aztec Code

Data Matrix MaxiCode

**QR** Code

Postal decode Australian Post

symbologies British Post Canadian Post

China Post IMB

Japanese Post KIX Post

Planet Code

Portuguese Post Postnet

Royal Mail Code (RM4SCC) Swedish Post

Stacked decode GS1 DataBar Composites

**symbologies** GS1 DataBar Expanded Stacked GS1 DataBar

Stacked

GS1 DataBar Stacked Omnidirectional Micro

PDF417 PDF417

Mechanical

**Dimensions (LxWxH)** 6.0 x 7.5 x 8.4 cm (2.4 x 3.0 x 3.3 in)

Weight170 g (6 oz)Cable length2 m (6.5 ft)ColorBlack

Interface/Connection

Interface USB-A

**Temperature** 

 $\begin{array}{ll} \textbf{Operating} & 0 \ \text{to} \ 40 \ ^{\circ}\text{C} \ (32 \ \text{to} \ 104 \ ^{\circ}\text{F}) \\ \textbf{Storage/transport} & -40 \ \text{to} \ 70 \ ^{\circ}\text{C} \ (-40 \ \text{to} \ 158 \ ^{\circ}\text{F}) \\ \end{array}$ 

Humidity(non- 5-95%

condensing)

Power

Standby 300mA Current 500mA

Operating

Reliability

Ambient Light 0 to 86,100 lux

Water Penetration IP52

**Protection** 

**Drop ESD** 1.2 m (4.0 ft)

25kV

**Drivers** 



## Overview - After Market Options

Windows UBB HID-KB and OPOS & JPOS (via USB-COM mode drivers)

**Operating System** 

Compatible with: Windows

Windows 10 IoT Enterprise for Retail (64-bit)

Windows 10 Pro (64-bit)

Linux

Red Hat/Cento 6 and 7 (32-bit and 64-bit)

Suse Linux® Enterprise POS 11 SP3 (32-bit and 64-bit)

Ubuntu14.04LTS(32-bit and 64-bit)

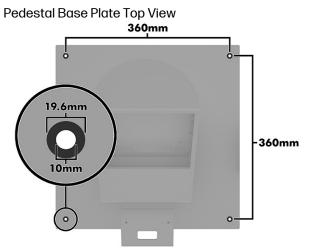
**Agency Certifications** 

IEC62368



Overview - After Market Options

## HP Engage Express Pedestal Stand Mounting



Note: HP Engage Express Pedestal Stand must be bolted to the floor, bolts not included.

## HP Engage Express Countertop & Pedestal Dimensions with HP Engage One Pro AiO

**NOTE:** Weight and dimensions below do not include MSR, Biometric Reader, Countertop BCS Cradle, Bag Holder, Shelves, and Payment Arm.

Description	Length/Depth (in/mm)	Width (in/mm)	Height (in/mm)
Countertop + 15.6" Landscape	13.78/350.00	15.65/397.56	23.08/586.18
Countertop + 15.6" Portrait	13.78/350.00	13.78/350.00	25.65/651.40
Countertop + 19.5" Landscape	13.78/350.00	19.48/494.80	24.01/609.95
Countertop + 19.5" Portrait	13.78/350.00	13.78/350.00	27.37/695.26
Countertop + 23.8" Landscape	13.78/350.00	22.36/568.00	24.78/629.37
Countertop + 23.8" Portrait	13.78/350.00	13.78/350.00	28.72/729.39
Pedestal + 15.6" Landscape	17.99/457.00	17.99/457.00	53.24/1352.18
Pedestal + 15.6" Portrait	17.99/457.00	17.99/457.00	55.41/1407.35
Pedestal + 19.5" Landscape	17.99/457.00	19.48/495.00	54.17/1375.95
Pedestal + 19.5" Portrait	17.99/457.00	17.99/457.00	57.53/1461.16
Pedestal + 23.8" Landscape	17.99/457.00	22.36/568.00	54.94/1395.37
Pedestal + 23.8" Portrait	17.99/457.00	17.99/457.00	58.87/1495.39
HP Engage Express Countertop Barcode Scanner Cradle (with HP Engage 2D G2 BCS)	13.78/350.00	5.61/142.50	3.85/97.85
HP Engage Express Shelves (2)	14.49/368.00	7.24/184.00	4.00/101.56



## Overview - After Market Options

HP Engage Express Bag Holder	8.52/216.37	13.37/339.50	13.75/349.31
HP Engage Express Countertop Mount	3.94/100.00	6.14/156.00	1.04/26.50
HP Engage Express Universal Payment Arm	7.15/181.70	3.50/88.94	2.24/56.97

## HP Engage Express Countertop and Pedestal Weights

AMO Number	AMO Name	Weights (lb/kg)
6P2E2AA	HP Engage Express Countertop 1	26.90/12.20
6P2E3AA	HP Engage Express Countertop 2	27.12/12.30
6P2E4AA	HP Engage Express Countertop 3	28.22/12.80
6P2E5AA	HP Engage Express Countertop 4	28.45/12.90
6P2E7AA	HP Engage Express Pedestal 5	79.37/36.00
6P2E8AA	HP Engage Express Pedestal 6	79.59/36.10
6P2E9AA	HP Engage Express Pedestal 7	80.69/36.60
6P2F0AA	HP Engage Express Pedestal 8	80.91/36.7
6P2F1AA	HP Engage Express Pedestal 9	81.57/37.00
6P2F2AA	HP Engage Express Pedestal 10	81.35/36.90
6P2F3AA	HP Engage Express Pedestal 11	82.01/37.20
9Y3Q7AA	HP Engage Express Pedestal 12	
6P2F9AA	HP Engage Express Countertop Barcode Scanner Cradle (with HP Engage 2D G2 BCS)	2.89/1.31
6P2G0AA	HP Engage Express Shelves	2.49/1.13 (per shelf)
6P2F7AA	HP Engage Express Bag Holder	2.34/1.06
7P9E2AA	HP Engage Express Countertop Mount	0.68/0.31
7Y397AA	HP Engage Express Universal Payment Arm	0.90/0.41
9Y3Q8AA	HP Engage Express Side Payment Arm	

## HP Engage One Pro All-in-One System Weight and Dimensions

NOTE: Weight and dimensions below are only HP Engage One Pro units and do not include MSR, Biometric Reader, Webcam, or CFD.

Head Unit-15.6"				
Metric US				
Head Unit-15.6" Dimensions (Landscape)				
Height [mm/in]	26.4	1.0		
Width [mm/in]	397.6	15.7		



## Overview - After Market Options

Depth [mm/in]	241.0	9.5
Volume (Liters/cubic inches)	2.5	154.35
Head Unit-15.6" Dimensions (Portrait)		
Height [mm/in]	26.4	1.0
Width [mm/in]	397.6	15.7
Depth [mm/in]	241.0	9.5
Volume (Liters/cubic inches)	2.5	154.35
Head Unit-15.6" Weight (Landscape)		
[kg/lb]	3.37	7.4
Head Unit-15.6" Weight (Portrait)		
[kg/lb]	3.35	7.4

Head	110	:+ 1	O E"	
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	Metric	US
Head Unit-19.5" Dimensions (Landscape)		
Height [mm/in]	29.4	1.2
Width [mm/in]	494.8	19.5
Depth [mm/in]	292.6	11.5
Volume (Liters/cubic inches)	4.3	259.75
Head Unit-19.5" Dimensions (Portrait)		
Height [mm/in]	29.4	1.2
Width [mm/in]	488.8	19.2
Depth [mm/in]	292.6	11.5
Volume (Liters/cubic inches)	4.2	256.60
Head Unit-19.5" Weight (Landscape)		
[kg/lb]	5.70	12.6
Head Unit-19.5" Weight (Portrait)		
[kg/lb]	5.69	12.5

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Head	いカル・シス	×

Metric	US



## Overview - After Market Options

Head Unit-23.8" Dimensions (Landscape)		
Height [mm/in]	29.4	1.2
Width [mm/in]	576.4	22.7
Depth [mm/in]	339.9	13.4
Volume (Liters/cubic inches)	5.8	351.50
Head Unit-23.8" Dimensions (Portrait)		
Height [mm/in]	29.4	1.2
Width [mm/in]	570.4	22.5
Depth [mm/in]	339.9	13.4
Volume (Liters/cubic inches)	5.7	347.84
Head Unit-23.8" Weight (Landscape)		
[kg/lb]	6.80	15.0
Head Unit-23.8" Weight (Portrait)		
[kg/lb]	6.79	15.0



## Overview - After Market Options

HP Engage One Pro VESA hub				
	Metric	US		
Dimensions				
Height [mm/in]	150.0	5.9		
Width [mm/in]	125.0	4.9		
Depth [mm/in]	24.4	1.0		
Weight(Without Adapter)				
[kg/lb]	0.54	1.20		

## HP Engage One Pro AiO Summary Dimension Matrix

Display Heads Only	Width (Horizontal)	Height (Vertical)	Thickness
15.6 Landscape	397.6	241.0	26.4
19.5 Landscape	494.8	292.6	29.4
23.8 Landscape	576.4	339.9	29.4
15.6 Portrait	241.0	391.6	26.4
19.5 Portrait	292.6	488.8	29.4
23.8 Portrait- Slim VESA only*	339.9	570.4	29.4



## Overview - After Market Options

## **ENVIRONMENTAL & INDUSTRY**

#### **Environmental Data**

Sustainable Impact Specifications

- Countertop: 5% Recycled Metal\*
- Pedestal: 9% Recycled Metal\*
- This product is 92% recycle-able when properly disposed of at the end of life.
- Metals used:
  - o Kiosk pedestal: aluminum
  - o Base plate: steel

Footnote: Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams.

#### **Packaging Materials**

**External:** Paper/Corrugated

Internal: Plastic/Polyethylene Expanded - EPE

Plastic/Polyethylene low density - LDPE

The EPE foam packaging material is made from 100% recycled content.

The corrugated paper packaging materials contains at least 35% recycled content.

The plastic bag is 100 % recyclable

#### Material Usage

This product does not contain any of the following substances above regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)



## Overview - After Market Options

Notes: \* EPE foam packaging material is considered "recycled" pre-Consumer. The scrap or waste EPE material from the manufacturing process of these EPE foam pieces are reintroduced into the manufacturing process.

## Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

## End-of-life Management and Recycling

HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered, or disposed of in a responsible manner.

## HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

PC Product Design ISO 14001 certificate

and

HP Operations ISO 14001 certificate



Overview - After Market Options

## Service and Support

Three-year (3-3-3) limited warranty delivers (three years) of on-site, next business day<sup>2</sup> service for parts and labor and complimentary limited technical support.<sup>3</sup> HP Engage Express Shelves, HP Engage Express Bag Holder, and HP Engage Express Countertop Mount are 3-year advanced exchange (3-3-0). Three-year onsite and labor are not available in all countries. Optional HP Care Pack for HP Engage One Pro All-in-One.<sup>1</sup> To choose the right level of service for your HP product, visit HP Care Pack Central: http://http://www.hp.com/go/cpc

#### **NOTES:**

- 1. Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.
- 2. On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.
- 3. Technical support applies only to HP-configured Compaq and third-party HP-qualified hardware and software. 24 x 7 support may not be available in some countries.

Date of change:	Version History:		Description of change:
January 27, 2025	From v1 to v2	Changed	Format
February 20, 2025	From v2 to v3	Changed	ENVIRONMENTAL & INDUSTRY section
May 14, 2025	From v3 to v4	Added	Engage Express section
June 3, 2025	From v4 to v5	Changed	OPERATING SYSTEM section
July 15, 2025	From v5 to v6	Changed	Format



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